

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID

Quality Requirement Category: Industrial

Features

- Single 5 V to 17 V application or Wide Input Voltage Range from 3.0 V to 17 V with external Vcc
- Output Voltage Range: 0.25 V to 3.04 V with external feedback resistor divider in SVID mode
- Enhanced Fast COT Engine Stable with Ceramic output Capacitors and no External Compensation
- Optional Forced Continuous Conduction Mode and Diode Emulation for Enhanced Light Load Efficiency
- Pin Programmable Switching Frequency from 600 kHz to 1.2 MHz in steps of 200 kHz
- Pin Programmable Output Voltage, Mode Selection, Current Limit with 16 Selectable Settings
- Pin Programmability for SVID slave addresses
- Monotonic Startup with Selectable Soft-Start Time via SVID & Pre-Bias Startup
- Digitally programmable load-line without any external components
- Operating temp: -40 °C < Tj < 125 °C
- Small Size: 5 mm x 6 mm PQFN
- Lead-free, Halogen-free and RoHS2 Compliant with Exemption 7a
- Datasheet is applicable to IC_Device_ID A7h

Applications

- Server Applications
- Storage Applications
- Telecom & Datacom Applications
- Distributed Point of Load Power Architectures

Description

The TDA38641 is an easy-to-use, fully integrated and highly efficient dc-dc regulator with Intel SVID interface. The controller utilizes Infineon's fast COT engine which simplifies the design efforts, and achieves faster transient response.

The onboard PWM controller and OptiMOS™ FETs with integrated bootstrap diode make TDA38641 a small footprint solution, providing high-efficiency power delivery for low voltage high current applications which may need an SVID interface.

TDA38641 is a versatile regulator, operating with wide input and output voltage range, offering four programmable switching frequency from 600 kHz to 1.2 MHz, and providing eight unique selectable current limits via the pin strap resistors.

It also features important protection functions, like the thermally compensated current limit, over voltage and under voltage protection, and thermal shutdown to give required system level security in the event of fault





conditions. The part supports programmable digital dc loadline, providing an additional tool to manage the transients for a given rail.

The TDA38641 provides extensive OVP, UVP, OCP, OTP & Boot UVLO fault protection. The controller requires the fewest possible external components and results in a simplified Bill of Materials (BOM).

TDA38641 is a pin configurable part. Only when test mode is enabled on the part it gets access to the registers internally. At this point a desired config file may be burned into the part.





Table of Contents

1	Ordering Information	5
2	Functional Block Diagram	6
3	Typical Application Diagram	7
4	Pin Descriptions	8
5	Absolute Maximum Ratings	10
6	Thermal Characteristics	12
7	Electrical Specifications	13
7.1	Electrical Characteristics	
8	Pin Strapped Resistor Configurations	18
9	Typical Efficiency and Power Loss Curves	
9.1	PV _{in} = 12 V, F _{sw} = Varying	
9.2	PV _{in} = 12 V, F _{sw} = 800 kHz	
9.3	PV _{in} = Varying, F _{sw} = 1000 kHz	21
10	Thermal De-rating curves	23
11	RDS(on) of MOSFET Over Temperature	24
12	Typical operating characteristics (-40 °C ≤ T _i ≤ +125 °C)	
13	General Description	
13.1	Intel Operating Mode	
13.2	Voltage Sense	27
13.3	VID Decoder	28
13.4	Test Mode	
13.5	I2C Interface (available only in test mode)	
13.6	Multiple Time Programming Memory (available only in test mode)	
13.7	Programming (available only in test mode)	
14	Theory of Operation	
14.1	Device Power-On	
14.2	Pre-bias startup	
14.3	Internal Low-Dropout (LDO) Regulator	
14.4 14.5	Fast Constant ON-Time Control Enable (EN) Pin	
14.5 14.6	Switching Frequency and FCCM/DEM Operation	
14.7	Intel Mode	
14.7.1	Intel Boot Mode	
14.7.2	Intel SVID Interface	
14.7.3	All Call SUPPORT	
14.7.4	VR13 Operation	33
14.7.5	VR14 Operation	33
14.7.6	Set Work Point	33
14.8	Program Pin (SV_ADDR/PROG)	36
14.9	Soft Start	
14.10	Load-line	
14.11	Output Voltage Differential Sensing	
14.12	VRRDY	
15	Faults and Protection	
15.1	Over Current Protection (OCP)	
15.2	Output Under Voltage Protection (UVP)	40





15.3	Over Voltage Protection (OVP)	40
15.4	Over Temperature Protection (OTP)	
15.5	Boot Under Voltage Lockout (UVLO)	42
15.6	Minimum On - Time and Minimum Off - Time	42
15.7	High-Side Short (HSS) Detection	42
16	Fault Communication	43
16.1	Real-Time Telemetry in	43
16.2	PMBus Commands Supported	43
16.3	11-BIT Linear Data Format	48
16.4	16-BIT Linear Data Format	48
16.5	SVID Registers	49
17	Design example	54
17.1	Enabling the TDA38641	54
17.2	Programming the Switching Frequency and Operation Mode	54
17.3	Selecting Input Capacitors	54
17.4	Inductor Selection	55
17.5	Output Capacitor Selection	55
17.6	Output Voltage Programming	56
17.7	Bootstrap Capacitor	56
17.8	PVIN, and VCC/LDO bypass Capacitor	
17.9	Design Recommendations	56
18	Layout Recommendations	57
18.1	PCB Metal and Component Placement	57
18.2	Solder Resist	58
18.3	Stencil Design	59
19	Package	61
19.1	Marking Information	61
19.2	Dimensions	61
19.3	Tape and Reel Information	64
20	Environmental Qualifications	65
21	Pavision history	66

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID **Ordering Information**



Ordering Information 1

Ordering Information Table 1

Sales Part	Package Type	Standard Pack		Orderable Part Number	Part type
Number		Form and Qty			
TDA38641-aabb	QFN 5 mm x 6	Tape and	5000	TDA386410000AUMA1	40A Generic part – SVID
	mm	Reel			controlled configuration

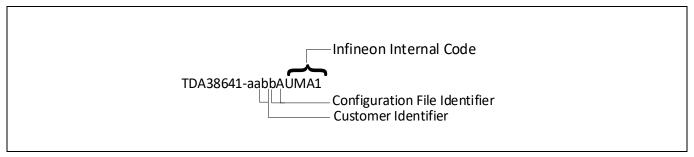


Figure 1 **Orderable Part Number Description**

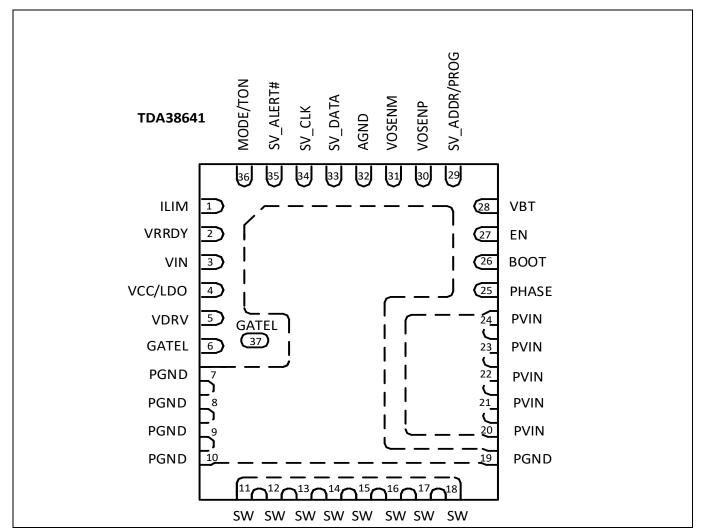


Figure 2 **Package Top View**



2 Functional Block Diagram

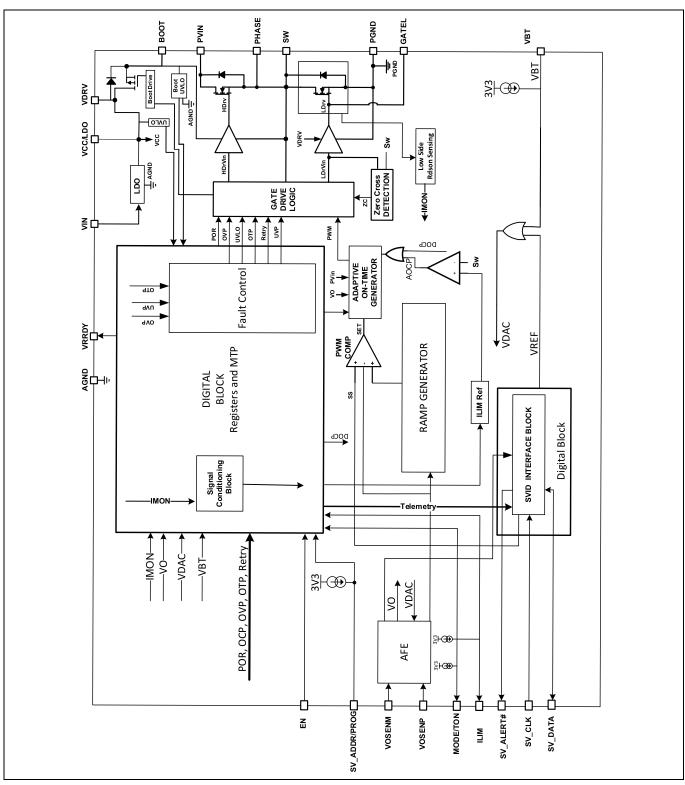


Figure 3 Block Diagram



Typical Application Diagram

3 Typical Application Diagram

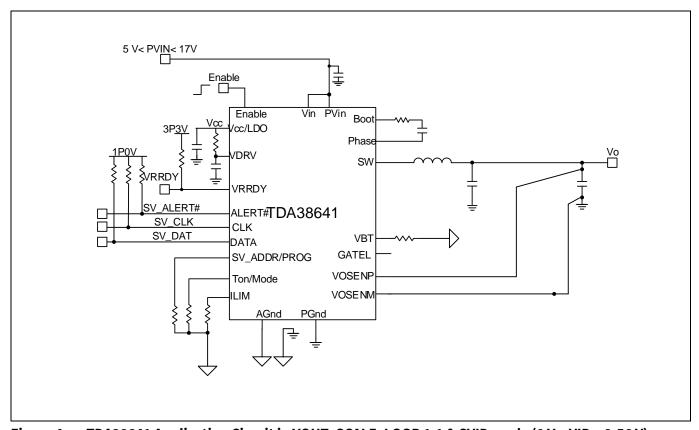


Figure 4 TDA38641 Application Circuit in VOUT_SCALE_LOOP 1:1 & SVID mode (0 V ≤ VID ≤ 2.56 V)

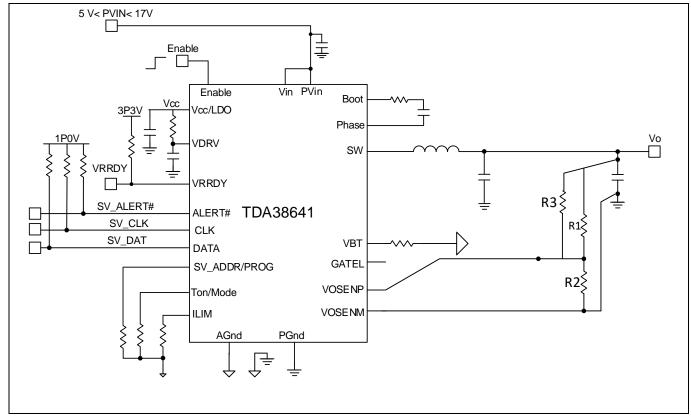


Figure 5 TDA38641 Application Circuit in VOUT_SCALE_LOOP 1:2 & SVID mode (2.56 V ≤ VID ≤ 3.04 V)

Final Datasheet 7 of 67 V2.3

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Pin Descriptions



4 Pin Descriptions

Table 2 Pin Descriptions

Note:

- 1. A- Analog; D- Digital; [I]- INPUT; [O]- OUTPUT; [B]- BI-DIRECTIONAL; [P]- POWER
- 2. Refer to Section 8 for more details

Pin#	Pin Name	Pin Type	Pin Description
1	ILIM	A [I]	Connect a resistor to ground to set Over Current Protection (OCP) limit. Eight user-selectable OCP limits are available.
2	VRRDY	D [O]	Open-drain output that asserts high when the VR has completed soft-start to boot. Pull-up to an external voltage through a resistor.
3	VIN	A [I]	Input voltage for an Internal LDO. A 4.7 uF capacitor should be connected between this pin and PGND. If an external supply is connected to the Vcc/LDO pin, this pin should be shorted to the Vcc/LDO pin and a 2.2 uF ceramic capacitor can be shared with Vin and Vcc/LDO.
4	Vcc/LDO	A [P]	Input bias for an external Vcc voltage /Output of the internal LDO. A 2.2 uF ceramic capacitor is recommended to use between Vcc, VDRV and the Power ground (PGND). An optional decoupling capacitor can be placed between Vcc/LDO and AGND. Connect to external supply when internal LDO not being used.
5	VDRV	A [P]	VDRV should be shorted to the Vcc/LDO pin on the PCB. A 2.2 uF ceramic capacitor is recommended to use between VDRV, Vcc/LDO and the Power ground (PGND). Connect to external supply when internal LDO not being used.
6, 37	GATEL	A [O]	Gate of Low-side FET. The signal on this pin should be used for test purposes only and should not have external components connected to it. Leave it open if not used.
7, 8, 9, 10, 19	PGND	-	Power Ground. Should be connected to the system's power ground plane. PGND and AGND are internally connected via the lead frame.
11, 12, 13, 14, 15, 16, 17, 18	SW	A [O]	Switch Node. Connect these pins to an output inductor.
20, 21, 22, 23, 24	PVin	A [P]	Input supply for the power stage.
25	Phase	A [O]	Source of High-side FET. Connect a bootstrap capacitor between this pin and Boot pin. A high temperature (X7R) 0.1 uF or greater value ceramic capacitor is recommended.
26	Boot	A [I]	Supply voltage for the high side driver. Connect this pin to the Phase pin of the regulator through a bootstrap capacitor. For PVin above 14 V, a resistor is recommended in series with the bootstrap capacitor to control the slew rate of the SW node rising edge.
27	EN	A [I]	Enable pin to turn on and off the IC. Leave it open or ground it when not used.

34

35

36

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Pin Descriptions

D [I]

D [O]

A [I]

SV_CLK

SV_ALERT#

MODE/TON



Pin# **Pin Name** Pin Type **Pin Description** A resistor from this pin to ground defines the default boot 28 VBT A[I] voltage that the part will boot up in. I2C Slave Address. A resistor to ground on this pin points to one of the unique 14 SVID slave devices² which needs to be D [I] 29 SV_ADDR/PROG addressed on the board. The same address also defines the specific configuration file that will be loaded into the OTP during power-up. Direct sense output line connected after the switch node A [I] 30 VOSENP inductor. This pin provides the return connection for remote output A [I] voltage sensing. It is used as the internal reference voltage by 31 **VOSENM** the Analog Front End (AFE). Signal ground for the internal circuitry. Connect it to the 32 AGND PGND power plane. Serial VID Data I/O. This is a bi-directional serial line over 33 SV_DATA D [B] which the CPU Master issues commands and receives data back. Leave the pin open or Ground it if not being used.

Serial VID Clock Input. Clock input driven by the CPU Master.

Serial VID ALERT# (INTEL). SV ALERT# is pulled low by the

controller to alert the CPU of VR 14/13/12/12.5 status. Leave

Multi-function pin. This pin can be used to select one of eight

switching frequencies, and FCCM or DEM mode by connecting

Leave the pin open or Ground it if not being used.

the pin open if not being used.

a resistor from this pin to ground.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Absolute Maximum Ratings



5 Absolute Maximum Ratings

Stresses above those mentioned in Table 3 below may result in permanent damage to the device. These are the absolute stress ratings only and the operation of the device is not recommended or implied at these or any other condition's in excess of those given in the recommended operating ratings in Table 5. Exposure of values over and above the recommended ratings for extended periods may adversely affect the operation and reliability of the device.

Table 3 Absolute Maximum Ratings

D	Complete I	Values				Note/ Test	
Description	Symbol	Min Typ		Max	Unit	Conditions	
Power Input Voltage	V _{PVIN}	-0.3	-	25	V	Note 3, PVIN Pin	
Positive Input-Current- Sense voltage	V _{IN}	-0.3	-	25	V	Note 3, VIN Pin	
Enable voltage	V _{EN}	-0.3	-	25	V	EN Pin	
PVIN-PHASE voltage	V _{PVIN} -V _{PHASE}	-5 V for 5 ns, -0.3 V dc	-	34 V for 1 ns, 25 V dc	V	PVIN-PHASE pin	
PVIN-Switch Node voltage	V _{PVIN} -V _{SW}	-5 V for 5 ns, -0.3 V dc	-	34 V for 1 ns, 25 V dc	V	PVIN- SW Pin	
Internal Driver voltage	V_{DRV}	-0.3	-	6	V	Note 3, VCC/VDRV Pin	
Gate Low Pin voltage	V_{GATEL}	-0.3	-	6	V	GateL Pin	
DOOT II	V _{BOOT}	-0.3 V for 5 ns, -0.3 V dc	-	29 V dc	V	BOOT Pin	
BOOT voltage	V _{BOOT} - V _{PHASE}	-0.3	-	7 V for 5 ns, 6 V dc	V	BOOT – PHASE Pin	
Switch Node voltage	V _{SW}	-7 V for 5 ns, -0.3 V dc	-	34 V for 1 ns, 25 V dc	V	Switch Node Pin	
Phase Node voltage	V _{PHASE}	-7 V for 5 ns, -0.3 V dc	-	34 V for 1 ns, 25 V dc	V	Phase Pin	
Address/PROG voltage	V _{SV_ADDR/PROG}	-0.3	-	3.6	V	Note 3, SV_ADDR/PROG Pin	
Output Positive Sense voltage	V _{VOSENP}	-1.5 V for 5 ns, -0.3 dc	-	3.6	V	Note 3, VOSENP Pin	
Output Negative Sense voltage w.r.t AGND	V _{VOSENM}	-0.3	-	0.3	V	Note 3, VOSENM Pin	
Voltage Regulator Ready voltage	V_{VRRDY}	-0.3	-	3.6	V	Note 3, VRRDY Pin	
ILIM Voltage	V _{ILIM}	-0.3	-	3.6	V	Note 3, ILIM Pin	
MODE/TON voltage	V _{MODE/TON}	-0.3	-	3.6	V	Note 3, MODE/TON Pin	
VBT voltage	V _{VBT}	-0.3	-	3.6	V	Note 3, VBT voltage pin	
Power GND w.r.t Analog GND voltage	V _{PGND} - V _{AGND}	-1.5 V for 5 ns , -0.3 dc	-	1.5 V for 5 ns, 0.3 dc	V	PGND – AGND Pin	



40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID

Absolute Maximum Ratings

Dagawintian	Complete	Values				Note/ Test	
Description	Symbol	Min	Тур	Max	Unit	Conditions	
SVID CLK voltage	V _{SV_CLK}	-0.3	-	3.6	V	SV_CLK Pin	
SVID Data voltage	V_{SV_DAT}	-0.3	-	3.6	V	SV_DAT Pin	
SVID Alert voltage	V _{SV_ALERT#}	-0.3	-	3.6	٧	SV_ALERT# Pin	
Junction Temperature	T_{Jmax}	-40	-	150	°C	-	
Storage Temperature	T _{STORAGE}	-55	-	150	°C	-	

Note:

3. PGND and AGND pins are connected together

Attention: Stresses beyond these listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Thermal Characteristics

6 Thermal Characteristics

Table 4 Thermal Characteristics

Description	Symbol	Values	Test Conditions
Junction to Ambient Thermal Resistance	θ_{JA}	19 °C/W	Note 4
Junction to PCB Thermal Resistance	$\theta_{\text{JC-PCB}}$	1.1 °C/W	Note 5
Junction to Case Top Thermal Resistance	θ _{JC}	24 °C/W	

Note:

- 4. Thermal resistance is measured with components mounted on a standard EVAL_TDA38641_1.1Vout demo board in free air
- 5. Thermal resistance is based on the board temperature near pin 22

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Electrical Specifications



7 Electrical Specifications

Table 5 Recommended Operating Conditions for Reliable Operation

Description	Min	Max	Unit	Note
PVin Voltage Range with External Vcc	3	17	V	Note 6, Note 7
PVin Voltage Range with Internal LDO	5	17	V	Note 7, Note 8 & Note 11
Vcc Supply Voltage Range	4.5	5.5	V	Note 6 , Note 9
Output Voltage Range	0.25	3.04	V	Note 10
Continuous Output Current Range		40	А	Note 11
Switching Frequency	600	1200	kHz	Note 12
Operating Junction Temperature	-40	125	°C	

Note:

- 6. VCC/VDRV pin is connected to an external bias voltage for PVIN less than 5 V
- 7. A common practice is to have 20% margin on the maximum SW node voltage in the design. For applications requiring PVin equal to or above 14 V, a small resistor in series with the Boot pin should be used to ensure the maximum SW node spike voltage does not exceed absolute maximum dc and ac specs. Alternatively, a snubber can be used at SW node to reduce the SW node spike.
- 8. PV_{in} with internal LDO is used. For single-rail applications with the internal LDO and $PV_{in} = 5 \text{ V-6 V}$, the internal LDO may enter dropout mode. AOCP limits can be reduced due to the lower VCC voltage.
- 9. The TDA38641 is designed to function with VCC down to 4.5 V, however, electrical specifications such as AOCP limits may be degraded.
- 10. The maximum output voltage is limited by the minimum off-time. For output voltages above 2.56 V, an external feedback resistor divider is needed. The limitation of 3.04 V is valid only in SVID mode, for PMBus mode this goes up to 5.12 V.
- 11. Refer to Section 14.1 for maximum output current rating at different ambient temperatures and OCP threshold tolerance.
- 12. The maximum LDO output current must be limited within 60 mA for operations requiring the full operating temperature range of -40 °C $\leq T_J \leq$ 125 °C. Thermal De-rating may be needed at an elevated ambient temperature to ensure the junction temperature remains within the recommended operating range.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Electrical Specifications



7.1 Electrical Characteristics

Unless otherwise specified, these specifications apply over, $5 \text{ V} \le \text{PVin} \le 17 \text{ V}$, in $0 ^{\circ}\text{C} < \text{T}_{\text{J}} < 125 ^{\circ}\text{C}$. Typical values are specified at Ta = $25 ^{\circ}\text{C}$.

Table 6 Electrical Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Power Stage						
Top Switch	$R_{ds(on)_Top}$	VBoot – Vsw = 5.0 V, IO = 35 A, Tj = 25 °C	-	2.9	-	0
Bottom Switch	R _{ds(on)_Bot}	Vcc = 5.0 V, IO = 35 A, Tj =25 °C	-	1.0	-	mΩ
Bootstrap Diode Forward Voltage		I(Boot) = 25 mA	-	780	950	mV
		SW = 0 V, EN = 0 V	-	-	175	
SW Leakage Current	I _{SW}	SW = 0 V, EN = high, No Switching	-	-	175	μΑ
	_	SW Node rising edge, 40 A, Internal LDO, T _j =25 °C, Note 13	-	10	-	
Dead Band Time	T _{db}	SW Node falling edge, 40 A, Internal LDO, Tj = 25 °C, Note 13	-	10	- ns	— ns
Supply Voltage	PVin and Exte	rnal Vcc				
PVin range (using external VCC = 5V)			-	3 - 17	-	V
External Vcc Range			4.5	5	5.5	V
Supply Current	lin					
PVin Supply Current (standby, LDO)	l _{in (Standby)}	EN = Low, No Switching	1	12	-	mA
PVin Supply Current (dynamic, LDO)	I _{in (Dyn)}	EN=High, F _{sw} = 800 kHz, PVIN = 12 V, Vout = 1.1 V, Note 15	-	48	-	mA
Digital Inputs	VR_ENx (Intel)				
Input High Voltage			0.70	-	-	V
Input Low Voltage			-	-	0.50	V
Input Impedance			-	1	-	МΩ
Digital Inputs	SV_CLK, SV_D	AT				
Input High Voltage			0.65	-	-	V
Input Low Voltage			-	-	0.45	V
Hysteresis			-	95	-	mV
Input Leakage Current		SV_CLK = 3.6 V	-1	-	1	μА
Pin Capacitance		See Note 13	-	-	4	pF
Remote Voltage Sense Inputs	VOSENP, VOS	ENM				



40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Electrical Specifications

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
VOCEND Input Comment		VOSENP = 3.6 V			230	μА
VOSENP Input Current		VOSENP = -0.3 V	-85	-	-	μА
VOSENM Input Current		VOSENM = 0.3 V	-155	-	-	μΑ
		VOSENM = -0.3 V	-200	-	-	μΑ
Differential Input Voltage Range			-	-	2.56	V
VOSENM Input CM Voltage			-	±300	-	mV
MODE/TON pin		•				
Output Current			-	104	-	μΑ
VBT/ILIM pin						
Output Current			-	15	-	μΑ
Analog Address/Level Inputs	SV_ADDR/PRO)G			1	· ·
Output Current			-	15	-	μΑ
Open-Drain Outputs- 20mA Drive	VRRDYx			•		
Output Low Voltage		I = 20 mA	-	-	0.3	V
Output Leakage		V _{VRRDY} = 3.6 V	-5	-	5	μΑ
Open-Drain Outputs- 20mA Drive	SV_DAT,SV_AI	ERT#		•	•	•
Output Low Voltage		I = 20 mA	-	-	0.26	V
On Resistance		I = 20 mA	4	-	13	Ω
Tri-State Leakage		0 – 3.6 V	-5	-	5	μА
On-Time Timer				•	•	
Frequency Range (programmable)		Four frequencies in step of 200 kHz	600		1200	kHz
Minimum On-Time		Tj=25 °C, Note 13, PVIN = 12 V, Vo = 0 V, See Note 15	-	25	-	ns
Minimum Off-Time	Toff (Min)	Tj=25 °C, VFB=0 V, See Note 13	-	150	-	ns
System Set Point Accurac	y (5 mV and 10	mV step mode voltage)				
VBOOT Voltage Range			Meets S _I	pec	_	V
0.25 V ≤ VID ≤ 0.795 V		-40 °C ≤ T _J ≤ 125 °C	-	±10	-	mV
0.8 V ≤ VID ≤ 0.995 V		VDD > VID + 200 mV	-	±8	-	mV
1.0 V ≤ VID ≤ 2.52 V		Typ = 3σ, Note 13 & 14	-	±1	-	%VID
VCC LDO Output	Vcc		T			1
Vcc Output Voltage	Vcc	$5.5 \text{ V} \leq \text{PVIN} \leq 17 \text{ V},$ when Icc = 50 mA, Cload = 2.2 uF, T_j =25 °C	4.7	5.0	5.3	V
VCC Dropout	Vcc_drop	PVIN = 4.5 V, Icc = 50 mA, Cload = 2.2 uF, T _j = 25 °C	-	650	-	mV



40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Electrical Specifications

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Inder Voltage Lockout						
Vcc_Good Start Threshold	VCC_UVLO_Start	Vcc Rising Trip Level	3.8	-	4.2	.,
Vcc_Good Stop Threshold	VCC_UVLO_Stop	Vcc Falling Trip Level	3.6	-	4.0	V
Enable-Start-Threshold	Enable_UVLO_Star	ramping up	0.61	0.65	0.69	
Enable-Stop-Threshold	Enable_UVLO_Sto	ramping down	0.51	0.55	0.59	V
Boot Rising Threshold	BOOT_UVLO_Risin	Boot-Phase Ramping up, Note 13	3.7	3.85	4.0	V
Boot Falling Threshold	BOOT_UVLO_Falli	Boot-Phase Ramping down, Note 13	3.5	3.65	3.8	V
Over Current Limit						
			-	10	-	
			-	15	-	
			-	20	-	4
Current Limit Threshold	I _{oc}	Tj = 25 °C, Vcc = 5.0V	-	25	-	A
(Valley Current)		, ,	-	30	-	
			-	40 50	-	
				60	_	-
Current Limit Threshold Accuracy		See Note 13	-	± 20	-	%
ver Voltage Protection		L		I	I	
			_	0.8	_	
			_	1.0	-	
			_	1.2	_	V
		In SVID and	_	1.35	_	
		VOUT_SCALE_LOOP	_	1.55	_	
		1:1 mode		1.8	_	
				2.2		-
			-		-	_
			-	2.85	-	
Output Fixed OVP Threshold Accuracy		See Note 13	-5	-	5	%
Output Relative OVP Threshold (programmable via the pin)		Relative to VID in steps of 50 mV in VOUT_SCALE_LOOP 1:1 mode	50	-	400	mV
Output Relative OVP Threshold Accuracy		Relative to VID in steps in VOUT_SCALE_LOOP 1:1 mode	1	± 50	-	mV
Inder Voltage Protection						
Output Relative UVP Threshold (programmable via the pin)	UVP_Vth	Relative to VID in steps of 50 mV in VOUT_SCALE_LOOP 1:1 mode		-	400	mV

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40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Electrical Specifications

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output Relative UVP Threshold Accuracy		Relative to VID in steps; in VOUT_SCALE_LOOP 1:1 mode	-	± 50	-	mV
Reporting				•		•
Highest Reported Vout		VOUT_SCALE_LOOP=1 :1 and in SVID MODE	-	-	2.56	V
Vout Reporting Accuracy		-40 °C - 125 °C (Tj), 4.5 V < Vcc < 5.5 V, 0.25 ≤ VID ≤ 0.5; VOUT_SCALE_LOOP in 1:1 mode	-2	-	2	%
		-40 °C - 125 °C (Tj), 4.5 V < Vcc < 5.5 V, 0.5 < VID ≤ 2.52; VOUT_SCALE_LOOP in 1:1 mode	-1	-	1	%
lout Resolution			-	0.0625	-	А
Iout Digital Monitoring Range			-		64	А
lout Reporting Accuracy		0 °C-125 °C, 4.5V <vcc<5.5v 0 A ≤ lout ≤ 40 A 0.25 V ≤ Vout ≤ 2.52 V, Note 15</vcc<5.5v 	-	±6	-	%
Temperature Resolution			-	1	-	°C
Temperature Monitoring Range			-40	-	125	°C
Temperature Reporting Accuracy		See Note 13	-	±1	-	°C
Thermal Shutdown		See Note 13	-	140	-	°C
Thermal Shutdown Hysteresis		See Note 13	-	20	-	°C

Note:

- 13. Guaranteed by design and not tested in production
- 14. Cold temperature performance is guaranteed via correlation using statistical quality control. Not tested in production.
- 15. Guaranteed by Bench Characterization at Room Temperature and not tested in production

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Pin Strapped Resistor Configurations

8 Pin Strapped Resistor Configurations

The tables and descriptions below detail different parameters that can be set using pin strap resistor.

Table 7 MODE/TON Table

Bin	R _{MODE/TON} (kΩ)	VID mode 0 <vbt<1.5v< th=""><th>VID mode 1.6<vbt<1.8v< th=""><th>Freq (kHz)</th><th>MODE</th></vbt<1.8v<></th></vbt<1.5v<>	VID mode 1.6 <vbt<1.8v< th=""><th>Freq (kHz)</th><th>MODE</th></vbt<1.8v<>	Freq (kHz)	MODE
0	SHORT	5 mV	10 mV	600	
1	2.49	5 mV	10 mV	1000	FCCM
2	3.24	10 mV	10 mV	800	FCCM
3	4.02	10 mV	10 mV	1200	
4	4.87	5 mV	10 mV	1200	
5	5.76	10 mV	10 mV	800	
6	6.81	10 mV	10 mV	1000	
7	7.87	10 mV	10 mV	1200	DEM
8	9.09	10 mV	10 mV	600	DEM
9	10.5	5 mV	10 mV	600	
10	12.1	5 mV	10 mV	800	
11	14	5 mV	10 mV	1000	
12	15.8	10 mV	10 mV	600	
13	17.8	10 mV	10 mV	1000	FCCM
14	20	5 mV	10 mV	1200	FCCM
15	FLOAT	5 mV	10 mV	800	

When operating in the pin strap resistor mode the switching frequency and the mode can be set by connecting a resistor from MODE/TON pin to GND per table above. Switching frequency can be selected from 600kHz to 1200kHz in steps of 200kHz. Mode can be selected between Forced Continuous Conduction Mode (FCCM) and Diode Emulation Mode (DEM). Furthermore, one can select the VID mode resolution between 5 mV and 10 mV using this table.

Table 8 TDA38641 Boot Up Voltage and OVP Limits Table for VOUT_SCALE_LOOP 1:1.

R_{VBT} ($k\Omega$)	BOOT-Up Voltage (V)	Relative OVP/UVP (mV)	Fixed OVP (V)
SHORT	0	150	1
5.62	0.75	150	1
9.53	0.8	150	1
14	0.85	150	1.2
21	0.9	200	1.2
30.1	0.95	200	1.2
36.5	1	200	1.35
43.2	1.05	200	1.35
51.1	1.1	200	1.35
61.9	1.2	200	1.5
75	1.25	250	1.8
88.7	1.35	250	1.8
105	1.5	300	2.2
127	1.6	300	2.2
150	1.7	350	2.2





Pin Strapped Resistor Configurations

FLOAT	1 1 0	1 300	1 2 2
ILOAI	1.0	300	Z.Z

When operating in the pin strap resistor mode, the output voltage can be selected by connecting a resistor from the VBT pin to GND per the table above.

Table 9 TDA38641 OCP and Internal Phase margin Zero selection

$R_{ILIM}(k\Omega)$	Typical OCP(A)	Internal Loop-Compensation- Filter-Zero Register (LCF)	Default LCF Zero Capacitance Value(pF), Note 16
SHORT	15	LCF 0	1
3.32	60	LCF 4	8
6.98	20	LCF 2	4
11	10	LCF 0	1
15.4	15	LCF 1	2
21	20	LCF 1	2
26.1	25	LCF 2	4
31.6	30	LCF 2	4
43.2	40	LCF 3	6
51.1	50	LCF 4	8
64.9	25	LCF 1	2
78.7	60	LCF 3	6
95.3	40	LCF 2	4
113	50	LCF 3	6
133	10	LCF 1	2
FLOAT	30	LCF 3	6

When operating in the pin strap resistor mode, the OCP limit can be selected by connecting a resistor from the ILIM pin to GND per the table above.

Note:

16. The default LCF value can be changed using Registers 0x64[14:12],0x62[2:0], 0x62[6:4],0x62[10:8],0x62[14:12] for LCF0, LCF1, LCF2, LCF3, and LCF4 respectively

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Typical Efficiency and Power Loss Curves

9 Typical Efficiency and Power Loss Curves

9.1 $PV_{in} = 12 V$, $F_{sw} = Varying$

The test for efficiency was done at 0 LFM and the driver losses are included in the efficiency numbers. Solid line indicate efficiency and dashed lines are showing power loss.

Table 10 Inductors for PVin=12 V, Fs = varying

Vout (V)	Lout (nH)	P/N	Frequency(kHz)	DCR (mΩ)	Inductor Size (mm³)	
1.1	100	14040474 4001	600	0.405		
(Ext. Vcc)	100	L101247A-100L	800	0.125	10 x 6.4 x 12	
			1000			

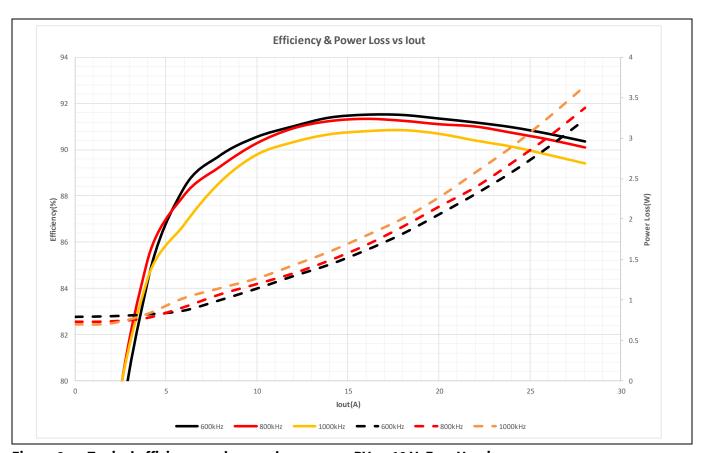


Figure 6 Typical efficiency and power loss curves, PV_{in} = 12 V, F_{sw} = Varying





Typical Efficiency and Power Loss Curves

9.2 $PV_{in} = 12 V, F_{sw} = 800 kHz$

The test for efficiency was done at 0 LFM and the driver losses are included in the efficiency numbers. Solid line indicate efficiency and dashed lines are showing power loss.

Table 11 Inductors for PVin=12 V, Fsw = 800 kHz

Vout (V)	Lout (nH)	P/N	Frequency(kHz)	DCR (mΩ)	Inductor Size (mm³)
1.1					
(Ext. Vcc)	100	L101247A-100L	800	0.125	10 v C 4 v 12
1.1					10 x 6.4 x 12
(Int. Vcc)					

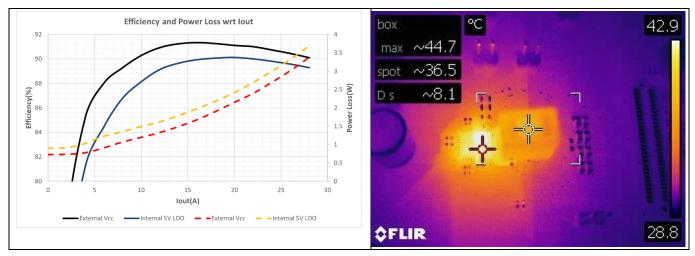


Figure 7 Typical efficiency & power loss curve plus thermal image at full load of 28 A with Internal LDO, $PV_{in} = 12 \text{ V}, F_{sw} = 800 \text{ kHz}$

9.3 $PV_{in} = Varying$, $F_{sw} = 1000 \text{ kHz}$

The test for efficiency was done at 0 LFM and the driver losses are included in the efficiency numbers. Solid line indicate efficiency and dashed lines are showing power loss.

Table 12 Inductors for PVin=Varying, Fsw = 1000 kHz

Vout (V)	Lout (nH)	P/N	PVIN(V)	DCR (mΩ)	Inductor Size (mm³)
			10.8		
1.1	100	L101247A-100L	12	0.125	10 x 6.4 x 12
(Int. Vcc)			13.2		

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Typical Efficiency and Power Loss Curves

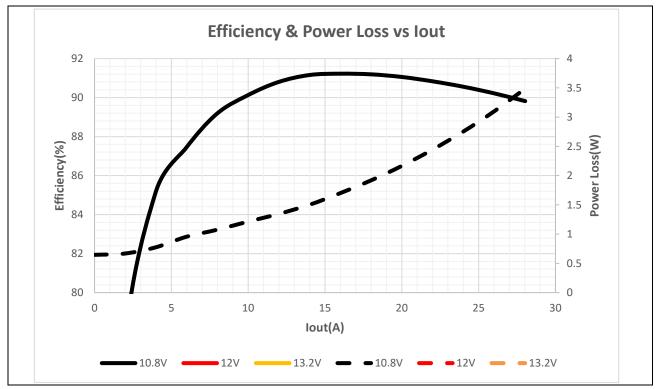


Figure 8 Typical efficiency and power loss curves, PV_{in} = Varying, F_{sw} = 1000 kHz

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Thermal De-rating curves

10 Thermal De-rating curves

This test is done on a DB356 Rev 2 Evaluation Board for TDA38641. It is an 8-layer board with 1 oz inner Cu layers and 2 oz on the top and bottom layer. FR4 material and the size of the eval board is 105 mm x 133 mm.

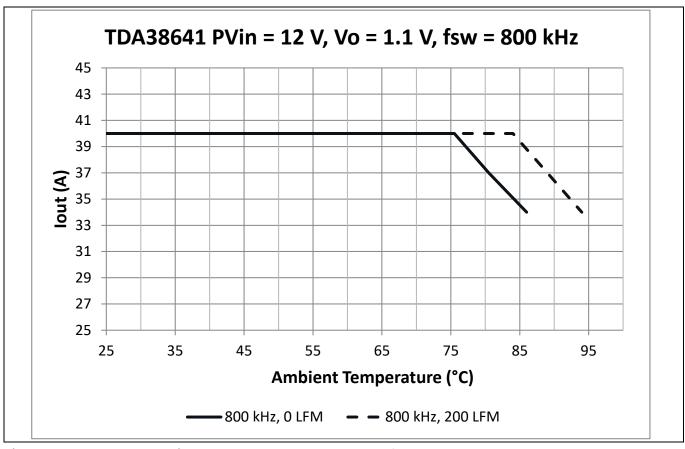


Figure 9 Thermal de-rating curves, PV_{in} = 12 V, V_{out}=1.1 V, f_{sw} = 800 kHz, VCC = Internal LDO



11 RDS(on) of MOSFET Over Temperature

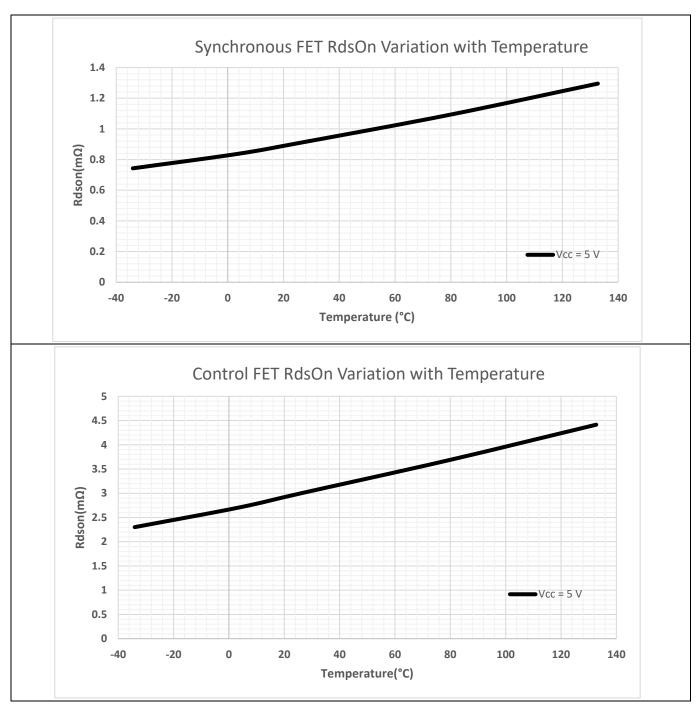


Figure 10 RDS(on) of MOSFETs over Junction Temperature

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Typical operating characteristics (-40 C \leq Tj \leq +125 C)

12 Typical operating characteristics (-40 °C \leq T_j \leq +125 °C)

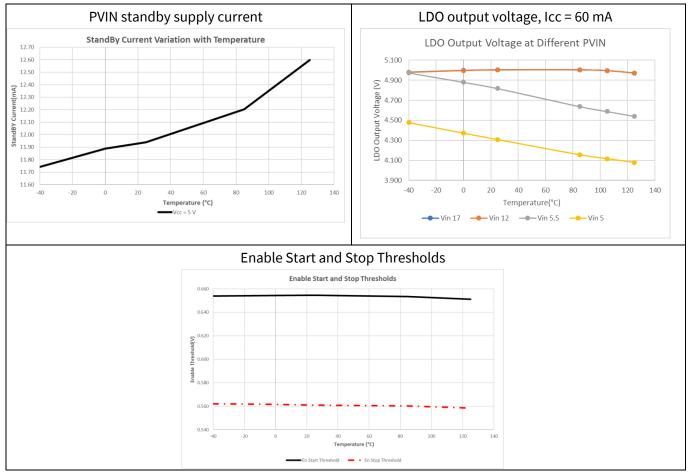


Figure 11 Typical operating characteristics (set 1 of 2)

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Typical operating characteristics (-40 C≤Tj≤+125 C)

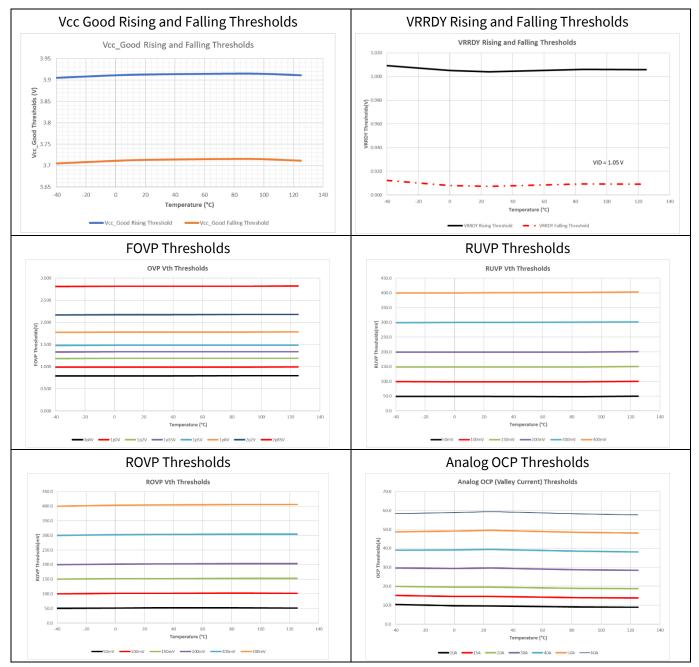


Figure 12 Typical operating characteristics (set 2 of 2)

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID General Description



13 General Description

The TDA38641 is an easy-to-use, fully integrated, and highly efficient dc-dc regulator optimized to convert a 12 V input supply to a voltage level required by high performance microprocessors and DDR memory. The onboard PWM controller and OptiMOS™ FETs with integrated bootstrap diode make TDA38641 a small footprint solution, providing high-efficiency power delivery. Using a fast Constant On-Time (COT) control scheme simplifies the design efforts and achieves fast control response. The device configuration may be defined using Infineon's XDP Designer GUI and is stored in the on-chip memory only when the device is in test mode.

13.1 Intel Operating Mode

The TDA38641 can be used for Intel® VR12, VR 12.5, VR13, VR14, IMPVP8 designs and DDR Memory without significant changes to the Bill of Materials (BOM). The required mode is selected in MTP and the pin-out, VID table and other relevant functions are automatically configured. This greatly reduces time-to-market and eliminates the need to manage and inventory different PWM controllers.

13.2 Voltage Sense

An error voltage is generated from the difference between the target voltage, defined by the VID and load line (if implemented), and the differentially sensed output voltage (remote sense). The error voltage is digitized by a high-speed, high-precision ADC. An anti-aliasing filter provides the necessary high frequency noise rejection. The gain and offset of the voltage sense circuitry for each loop is factory trimmed to deliver the required accuracy.

In order to obtain output voltages in the range of 2.56 V to 3.04 V, the VOUT SCALE LOOP 1:2 mode must be used, and a resistor divider from Vout to PGND is required. The center tap of the resistor divider is connected to the VOSENSP pin. In applications that require high Vout set point accuracy, a resistor in parallel to top resistor of the divider need to be connected as shown in Figure 5. The Value of the resistor is calculated as follows:

Rtop =
$$\frac{\text{Vo-Vfb}}{(\frac{\text{Vfb}}{\text{R2}} + \frac{\text{Vfb}}{13570} - \frac{1.2}{20000})}$$

Where

R1 is the top resistor of the divider
R2 is the bottom resistor of the divider
Req= Effective value of R1 and R3 in parallel
Vo=Target Output Voltage
Vfb= VOSENSP = Vo/2
R1, R2=499 Ohms (recommended)

$$R3 = \frac{R1xReq}{R1-Req}$$

For given feedback resistor values Vout is calculated as follows:

$$Vout = Vfb \left(1 + \frac{Req}{R2} + \frac{Req}{13570} \right) - 1.2x \frac{Req}{20000}$$

Suggested values of R1 anf R3 are as follows:

Target Vout (V)	R1, R2 (Ohms)	R3 (kOhms)
2.56	499	37.4
3.04	499	29.1

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID General Description



13.3 VID Decoder

The VID decoder receives a VID code from the CPU that is converted to an internal code representing the VID voltage. The 8-bit VID code supports Intel® VR13, VR14. Also, the user can program 5 mV or 10 mV VID steps depending on the protocol ID selected by the user.

13.4 Test Mode

The TDA38641 may be put into test mode by applying 3.6 V to SV_ADDR pin. When the device is in test mode the internal registers are accessible to the USER via the XDP GUI. In test mode the control and synchronous FET's are tri-stated, the address of the device is 0x0A and the pins ILIM and TON/MODE change personality to become SM_DAT and SM_CLK pins for I2C communication to the device. Once the changes are made in the registers the part should be power cycled and it goes back to being a pin-programmable buck regulator with SVID communication interface.

13.5 I2C Interface (available only in test mode)

An I2C or PMBus interface is used to communicate with the TDA38641. This two-wire serial interface consists of clock and data signals, and operates as fast as 1 MHz. The bus provides read & write access to the internal registers for configuration, and for monitoring of operating parameters. The bus is also used to program on-chip non-volatile memory (MTP) to store operating parameters.

To protect customer configuration and information, the I2C interface can be configured for either limited access or locked with a 16-bit software password. Limited access includes both write and read protection options. In addition, there is a telemetry-only mode which only allows reads from the telemetry registers.

13.6 Multiple Time Programming Memory (available only in test mode)

The multiple time programming memory (MTP) stores the device configuration. At power-up, MTP contents are transferred to operating registers for access during device operation. MTP allows customization during both design and high-volume manufacturing. MTP integrity is verified by Cyclic Redundancy Check (CRC) validation on each power up. The controller will not start up in the event of a CRC error.

The TDA38641 allows up to 13 unique configurations, to configure basic device parameters such as frequency, fault operation characteristics, and boot voltage. This represents a significant size and component saving compared to traditional analog methods. In addition to this, the TDA38641 also allows loading of multi-image (up to 13 consecutive) configuration files and automatic selection of a unique file after power-up based on the resistor value at the SV-ADDR/PROG pin and the pointer (0x0000[13:8]). There are registers available in the CNFG section of the register map which allow the user the capability to set the starting point for a multi-image (register 0x0000[13:8]) and number of images as part of the multi-image config file (register 0x0000[3:0]).

TDA38641 can be programmed successfully for an application up to 13 times for a single image config file. This should be done during offline programming or by using Infineon programming solution. Additionally, the TDA38641 also allows loading a maximum of 13 config files for the multi-image designs. Please refer to AN_2308_PL12_2308_163442 Programming Guide v1.1 for details on programming the part.

13.7 Programming (available only in test mode)

Once a design is complete, the GUI (XDP Designer) produces a configuration file. These configurations files can be saved and loaded. Infineon does not recommend loading a new config file and programming the device while the device is operating to produce an output voltage. Please refer to programming guide AN 2308 PL12 2308 163442 for more details.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Theory of Operation

14 Theory of Operation

14.1 Device Power-On

The on-chip regulator operates from the Vcc/VDRV and generates an internal +1.2 V voltage. TDA38641 operation is initialized by an internal threshold-based power-on reset circuit. To ensure no sensitive analog measurements is executed prior to Vcc/VDRV supply is settled, the controller provides a delay which extends the "System POR" state between power-on reset and entering the NVM Load state. This delay is used to ensure internal analog circuitry settles before making any precision measurements. After this, Trim and Config images are loaded from NVM to working registers. While waiting for the Trims to take effect, current sources are enabled at all pins that have external resistors (SM_ADDR/PROG). The resulting voltages are read through the low-speed ADC and latched. If Trim and Config CRC matches, User configuration is loaded from NVM to the working registers CRC check is carried out to validate the data in these registers. If the calculated CRC does not match the CRC stored in the NVM, CRC error is flagged and next sequences in ther start up are terminated. If there is a CRC match, the part continues with the start up sequence. The device starts switching once part is ready for regulation and communication and enable signal is pulled high. When the contents of the NVM are being loaded into the working registers the PWM outputs are held in high impedance (Hi-Z) state.

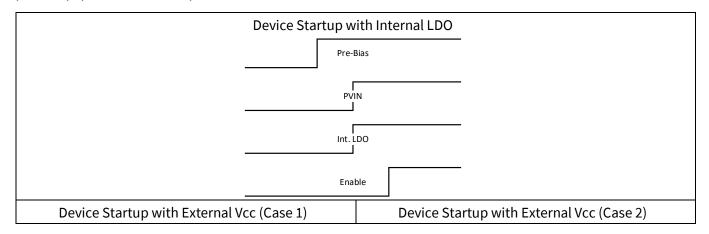
14.2 Pre-bias startup

TDA38641 is able to start up into a pre-charged output. The part supports prebias level of Vout setting or lower for VOUT_SCALE_LOOP 1:1 application. The part supports prebias level of half of Vout setting or lower for VOUT_SCALE_LOOP 1:2 application.

For proper start up in prebias mode, following conditions must be fulfilled:

- The "power down analog circuit when the output is not enabled" feature is disabled (set register 0x6C value to 0xF240)
- Register 0x0064[11], d2a_enable_prebias is set to 1
- PVIN Slew rate is lower than 25V/mS
- Prebias source is current limited to 1A
 Based on whether Vcc is supplied externally or an internal LDO is used, the required power-up sequences are shown in Figure 13 below

In applications that do not follow the above prebias operation requirements, the part may go into a protection mode when powered up with prebias condition. In most cases the part recovers from then fault upon cycling of EN. In applications that use external Vcc to power the part, and PVIN needs to be cycled OFF and ON after the first power up, please use the sequences shown in case 3 and 4 below.



40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Theory of Operation

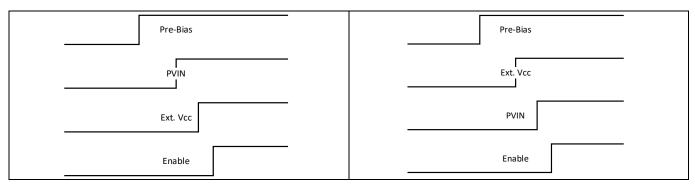


Figure 13 Device power-on sequence with pre-bias.

14.3 Internal Low-Dropout (LDO) Regulator

The TDA38641 has an integrated low-dropout LDO regulator, to provide the bias voltage for internal circuitry. When the Vcc UVLO start threshold and the enable voltage is above the Enable threshold, the soft-start sequence starts. When using the internal LDO for a single rail operation, PVIN internally acts as an input to the LDO block. To save the power losses on the LDO, an external bias voltage can be used by connecting it to the VCC/LDO pin. Additionally, it is recommended to set 0x64[3] to 1, this disables the internal LDO operation. Figure 14 illustrates the possible configurations of VCC/LDO, and PVIN pin.

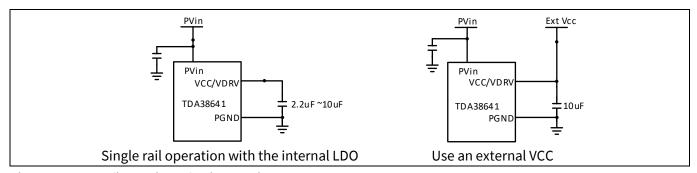


Figure 14 Configuration of using the internal LDO or an external VCC.

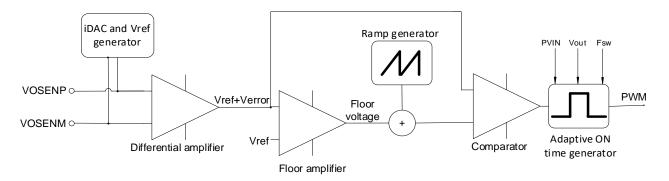
14.4 Fast Constant ON-Time Control

The TDA38641 features a proprietary Fast Constant On-Time (COT) Control, which can provide fast load transient response, good output regulation. During active regulation, the output voltage is applied as a feedback voltage alongwith Vref to a differential amplifier. Vref is proporatinal to the set Vout. The error voltage produced by differential amplifier is added to the Vref and fed to a floor amplifier. The difference between this input and Vref is amplified by floor amplifier to generate a floor voltage. The floor amplifier helps improve the transient response and Vout accuracy. Floor voltage and the ramp signal are added together and applied to the comparator and compared against error voltage. The resultant output is fed to Adaptive ON time generator. This block generates PWM signal of pseudo constant frequency. The Adaptive ON Time generator turns the PWM ON for a fixed duration based on the PVIN, Vout and Fsw. The PWM OFF time is determined by the set Fsw and output load. The output is regulated at the set level until the output is commanded OFF, Fault occurs, or POR is deasserted.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Theory of Operation



14.5 Enable (EN) Pin

The EN pin controls the on/off status of the TDA38641. When the VCC/LDO voltage rises above the VCC_UVLO_Start threshold, the soft-start sequence starts. The EN voltage needs to be toggled when the VCC voltage drops below VCC_UVLO_Stop and rises above the VCC_UVLO_Start threshold to start soft-start sequence.

The EN pin can be configured in three ways. All of them are shown in Figure 15. Configuration one is an external logic signal. The second possible configuration derives the enable signal from the PVin voltage by a resistive divider, R_{EN1} and R_{EN2} . The third one is a direct connection of EN to the PVIN pin. This is useful in space constrained applications.

If not used the EN pin may be left floating. There is an internal 1 M Ω pull down in the IC.

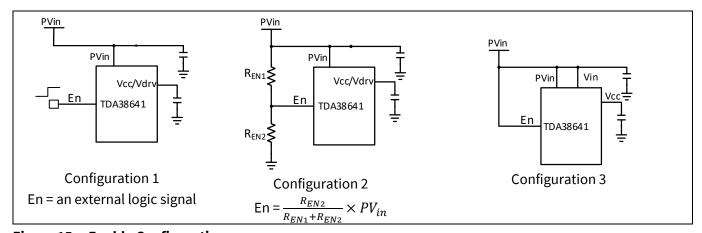


Figure 15 Enable Configurations

14.6 Switching Frequency and FCCM/DEM Operation

TDA38641 offers two operation modes: Forced Continuous Conduction (FCCM) and Diode Emulation Mode (DEM). With FCCM, the TDA38641 always operates as a synchronous buck converter with a pseudo constant switching frequency and therefore achieves small output voltage ripples. In DEM, the synchronous FET is turned off when the inductor current is close to zero, which reduces the switching frequency and improves the efficiency at light load. At heavy load, both FCCM and DEM operate in the same way. It should be noted that the selection of the operation mode cannot be changed on the fly. To load a new configuration, EN or VCC voltage needs to be cycled. The selection between FCCM and DEM is done based on the config table which is shown in Section on Pin Strapped Resistor Configurations.

The TDA38641 offers four pin programmable switching frequencies, f_{sw} , from 600 kHz to 1.2 MHz. Based on the selected resistor value (f_{sw}), the TDA38641 generates the corresponding on-time of the Control FET for a given PV_{in} and V_o, as shown by the formula below.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



$$T_{on} = \frac{V_0}{PV_{in}} \times \frac{1}{f_{sw}}$$

Where f_{sw} is the desired switching frequency. During the operation, the TDA38641 monitors PV_{in} and V_{o} , and can automatically adjust the on-time to maintain the pre-selected f_{sw} . With the increase of the load, the switching frequency can increase to compensate for the power losses. Therefore, the TDA38641 has a pseudo constant switching frequency.

To load a new TON/MODE configuration, EN or VCC voltage needs to be cycled.

14.7 Intel Mode

When the power-on sequence is initiated, and with VBOOT set to > 0 V, the output voltage will ramp to its configured boot voltage and assert VRRDY. The slew rate to VBOOT is programmed per VID_FAST/VID_SLOW commands.

If Vboot = 0 V, the VR will stay at 0 V and will not soft-start until the CPU issues a VID command to the loop. In VR13 mode, as soon as the IC is ready for SVID communication, SV_ALERT# will be asserted with Vboot = 0 V.

14.7.1 Intel Boot Mode

The TDA38641 Vboot voltage is fully programmable in MTP to the range specified in the Intel VID tables. Table 13 and Table 14 show the Intel VID tables for 5 mV and 10 mV VID steps respectively.

14.7.2 Intel SVID Interface

The TDA38641 implements a fully compliant Intel® VR 13, VR12, VR 12.5, and VR14 Serial VID (SVID) interface. This is a 3-wire interface between an Intel processor & VR that consists of clock, data and alert# signals.

The TDA38641 implements all the required SVID registers and commands per Intel specifications. For the selected Intel mode, the TDA38641 also implements most of the optional commands and registers with very few exceptions. The Intel CPU is able to detect and recognize the extra functionality that the TDA38641 provides and thus gives the Intel® VR 14/13/12/12.5 CPU unparalleled ability to monitor and optimize its power.

The SVID address of the TDA38641 defaults to 0. This address can be re-programmed in MTP(in test mode) or using the SV_ADDR/PROG pin. An address lock function prevents accidental overwrites of the address.

The pseudo-code below illustrates the MTP address programming:

unlock the address register to write, then lock
Set Address_lock_bit=0
Write new SVID address

14.7.3 All Call SUPPORT

All Call for each loop of TDA38641 can be configured in following ways:

- 0E and 0F.
- 0E only.
- 0F only.
- No All Call

TDA38641 can be configured (in test mode) to be used as VR for CPU which is All Call 0F or Memory which is All Call 0E.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Theory of Operation

14.7.4 VR13 Operation

VR 13 mode is selectable via MTP bit (0x44[12:8]). The boot voltage in VR 13 mode is configured in the boot register in test mode or by using the TON/MODE pin. In VR 13 mode, the boot voltage can be configured in 5 mV steps or 10 mV steps.

14.7.5 VR14 Operation

VR 14 mode is selectable via MTP bit (0x44[12:8]). The boot voltage in VR 14 mode is configured in the boot register in test mode or by using the TON/MODE pin. In VR 14 mode, the boot voltage can be configured in 5mV steps) or 10mV steps.

14.7.6 Set Work Point

TDA38641 supports SVID Set WP command to Set VID voltage for all rails through all call address. When processor asserts a Set WP command, all the rails of the VR settle to the corresponding new set-voltage encoded in WP registers. Slew rate and power state of all the rails are identical during a set work point operation.

Table 13 Intel 5mV VID Table (VR14 and VR13)

VID (Hex)	Voltage (V)								
FF	1.52	DA	1.335	B5	1.15	90	0.965	6B	0.78
FE	1.515	D9	1.33	B4	1.145	8F	0.96	6A	0.775
FD	1.51	D8	1.325	В3	1.14	8E	0.955	69	0.77
FC	1.505	D7	1.32	B2	1.135	8D	0.95	68	0.765
FB	1.5	D6	1.315	B1	1.13	8C	0.945	67	0.76
FA	1.495	D5	1.31	В0	1.125	8B	0.94	66	0.755
F9	1.49	D4	1.305	AF	1.12	8A	0.935	65	0.75
F8	1.485	D3	1.3	AE	1.115	89	0.93	64	0.745
F7	1.48	D2	1.295	AD	1.11	88	0.925	63	0.74
F6	1.475	D1	1.29	AC	1.105	87	0.92	62	0.735
F5	1.47	D0	1.285	AB	1.1	86	0.915	61	0.73
F4	1.465	CF	1.28	AA	1.095	85	0.91	60	0.725
F3	1.46	CE	1.275	A9	1.09	84	0.905	5F	0.72
F2	1.455	CD	1.27	A8	1.085	83	0.9	5E	0.715
F1	1.45	СС	1.265	A7	1.08	82	0.895	5D	0.71
F0	1.445	СВ	1.26	A6	1.075	81	0.89	5C	0.705
EF	1.44	CA	1.255	A5	1.07	80	0.885	5B	0.7
EE	1.435	C 9	1.25	A4	1.065	7F	0.88	5A	0.695
ED	1.43	C8	1.245	А3	1.06	7E	0.875	59	0.69
EC	1.425	C 7	1.24	A2	1.055	7D	0.87	58	0.685
EB	1.42	C6	1.235	A1	1.05	7C	0.865	57	0.68
EA	1.415	C 5	1.23	A0	1.045	7B	0.86	56	0.675
E9	1.41	C4	1.225	9F	1.04	7A	0.855	55	0.67
E8	1.405	C3	1.22	9E	1.035	79	0.85	54	0.665

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Theory of Operation

VID	Voltage	VID	Voltage	VID	Voltage	VID	Voltage	VID	Voltage
(Hex)	(V)	(Hex)	(V)	(Hex)	(V)	(Hex)	(V)	(Hex)	(V)
E7	1.4	C2	1.215	9D	1.03	78	0.845	53	0.66
E6	1.395	C1	1.21	9C	1.025	77	0.84	52	0.655
E 5	1.39	C0	1.205	9B	1.02	76	0.835	51	0.65
E4	1.385	BF	1.2	9A	1.015	75	0.83	50	0.645
E3	1.38	BE	1.195	99	1.01	74	0.825	4F	0.64
E2	1.375	BD	1.19	98	1.005	73	0.82	4E	0.635
E1	1.37	ВС	1.185	97	1	72	0.815	4D	0.63
E0	1.365	ВВ	1.18	96	0.995	71	0.81	4C	0.625
DF	1.36	ВА	1.175	95	0.99	70	0.805	4B	0.62
DE	1.355	В9	1.17	94	0.985	6F	0.8	4A	0.615
DD	1.35	B8	1.165	93	0.98	6E	0.795	49	0.61
DC	1.345	В7	1.16	92	0.975	6D	0.79	48	0.605
DB	1.34	В6	1.155	91	0.97	6C	0.785	47	0.6
46	0.595	37	0.52	28	0.445	19	0.37	0A	0.295
45	0.59	36	0.515	27	0.44	18	0.365	09	0.29
44	0.585	35	0.51	26	0.435	17	0.36	08	0.285
43	0.58	34	0.505	25	0.43	16	0.355	07	0.28
42	0.575	33	0.5	24	0.425	15	0.35	06	0.275
41	0.57	32	0.495	23	0.42	14	0.345	05	0.27
40	0.565	31	0.49	22	0.415	13	0.34	04	0.265
3F	0.56	30	0.485	21	0.41	12	0.335	03	0.26
3E	0.555	2F	0.48	20	0.405	11	0.33	02	0.255
3D	0.55	2E	0.475	1F	0.4	10	0.325	01	0.25
3C	0.545	2D	0.47	1E	0.395	0F	0.32	00	0
3B	0.54	2C	0.465	1D	0.39	0E	0.315		
3A	0.535	2B	0.46	1C	0.385	0D	0.31		
39	0.53	2A	0.455	1B	0.38	0C	0.305		
38	0.525	29	0.45	1A	0.375	0B	0.3		

Table 14 Intel 10mV VID Table (VR14 and VR13)

VID (Hex)	Voltage (V)								
FF	3.04	DC	2.69	В9	2.34	96	1.99	73	1.64
FE	3.03	DB	2.68	B8	2.33	95	1.98	72	1.63
FD	3.02	DA	2.67	В7	2.32	94	1.97	71	1.62
FC	3.01	D9	2.66	В6	2.31	93	1.96	70	1.61
FB	3.00	D8	2.65	B5	2.30	92	1.95	6F	1.60
FA	2.99	D7	2.64	B4	2.29	91	1.94	6E	1.59
F9	2.98	D6	2.63	В3	2.28	90	1.93	6D	1.58

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Theory of Operation

VID	Voltage	VID	Voltage	VID	Voltage	VID	Voltage	VID	Voltage
(Hex)	(V)	(Hex)	(V)	(Hex)	(V)	(Hex)	(V)	(Hex)	(V)
F8	2.97	D5	2.62	B2	2.27	8F	1.92	6C	1.57
F7	2.96	D4	2.61	B1	2.26	8E	1.91	6B	1.56
F6	2.95	D3	2.60	B0	2.25	8D	1.90	6A	1.55
F5	2.94	D2	2.59	AF	2.24	8C	1.89	69	1.54
F4	2.93	D1	2.58	AE	2.23	8B	1.88	68	1.53
F3	2.92	D0	2.57	AD	2.22	8A	1.87	67	1.52
F2	2.91	CF	2.56	AC	2.21	89	1.86	66	1.51
F1	2.90	CE	2.55	AB	2.20	88	1.85	65	1.50
F0	2.89	CD	2.54	AA	2.19	87	1.84	64	1.49
EF	2.88	CC	2.53	A9	2.18	86	1.83	63	1.48
EE	2.87	СВ	2.52	A8	2.17	85	1.82	62	1.47
ED	2.86	CA	2.51	A7	2.16	84	1.81	61	1.46
EC	2.85	C 9	2.50	A6	2.15	83	1.80	60	1.45
EB	2.84	C8	2.49	A5	2.14	82	1.79	5F	1.44
EA	2.83	C 7	2.48	A4	2.13	81	1.78	5E	1.43
E9	2.82	C6	2.47	A3	2.12	80	1.77	5D	1.42
E8	2.81	C5	2.46	A2	2.11	7F	1.76	5C	1.41
E7	2.80	C4	2.45	A1	2.10	7E	1.75	5B	1.40
E6	2.79	C3	2.44	A0	2.09	7D	1.74	5A	1.39
E5	2.78	C2	2.43	9F	2.08	7C	1.73	59	1.38
E4	2.77	C1	2.42	9E	2.07	7B	1.72	58	1.37
E3	2.76	C0	2.41	9D	2.06	7A	1.71	57	1.36
E2	2.75	BF	2.40	9C	2.05	79	1.70	56	1.35
E1	2.74	BE	2.39	9B	2.04	78	1.69	55	1.34
E0	2.73	BD	2.38	9A	2.03	77	1.68	54	1.33
DF	2.72	ВС	2.37	99	2.02	76	1.67	53	1.32
DE	2.71	ВВ	2.36	98	2.01	75	1.66	52	1.31
DD	2.70	BA	2.35	97	2.00	74	1.65	51	1.30
50	1.29	3E	1.11	2C	0.93	1A	0.75	08	0.57
4F	1.28	3D	1.10	2B	0.92	19	0.74	07	0.56
4E	1.27	3C	1.09	2A	0.91	18	0.73	06	0.55
4D	1.26	3B	1.08	29	0.90	17	0.72	05	0.54
4C	1.25	3A	1.07	28	0.89	16	0.71	04	0.53
4B	1.24	39	1.06	27	0.88	15	0.70	03	0.52
4A	1.23	38	1.05	26	0.87	14	0.69	02	0.51
49	1.22	37	1.04	25	0.86	13	0.68	01	0.50
48	1.21	36	1.03	24	0.85	12	0.67	00	0
47	1.20	35	1.02	23	0.84	11	0.66		
46	1.19	34	1.01	22	0.83	10	0.65		

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Theory of Operation



14.8 Program Pin (SV ADDR/PROG)

A resistor to ground on this pin sets the SVID slave address and selects a configuration from the 14 possible config files in the OTP during power-up. As shown in Table 15, the SV_ADDR pin selects the SVID slave address based on the resistor connected to the SV_ADDR/PROG pin. The PROG functionality is used to select one of the 14 images to load from the OTP. Please refer to section 13.6 for more details on the single and multi-image programming.

Table 15 SV_ADDR/PROG Pin

Resistor to GND $(k\Omega)$	PROG Functionality	SV_ADDR Functionality: SVID slave address	Programmability Access
SHORT	CONFIG0	0	Please refer to Section 13.6 for more details on single image and multi-image programming
5.62	CONFIG1	1	
9.53	CONFIG2	2	
14	CONFIG3	3	
21	CONFIG4	4	
30.1	CONFIG5	5	
36.5	CONFIG6	6	
43.2	CONFIG7	7	
51.1	CONFIG8	8	
61.9	CONFIG9	9	
75	CONFIG10	10	
88.7	CONFIG11	11	
105	CONFIG12	12	
127	CONFIG13	13	
147	NA	All Call	
FLOAT	NA	All Call	

14.9 Soft Start

The soft-start functionality is defined to support SVID commands for soft-start SetVID_Slow (0x44[1:0]) and SVID_fast (0x46[15:12]) commands are used to set the soft start timing to VID.

14.10 Load-line

TDA38641 offers digital load line which can be set via configuration registers in test mode, without any need for external components. The load line can be programmed from 0 to 10 m Ω at a resolution of 19.53 $\mu\Omega$ using the VOUT_DROOP command 0x250[15:0]. The range and resolution of the VOUT_DROOP may be increased by using the bit loadline_range_sel 0x6A [6] to 0 to 50 m Ω at a resolution of 100 $\mu\Omega$. In addition to this, the bandwidth of the digital load line is also programmable from 30 kHz to 500 kHz in steps of 30 kHz by using 4 bits of register 0x6A [3:0].

14.11 Output Voltage Differential Sensing

The TDA38641 VSEN and VRTN pins are connected across the output capacitors near the load to provide true differential remote voltage sensing with high common-mode rejection. Fast COT control compares the output voltage to a floor voltage combined with an internal ramp signal. When Vout drops below that signal, a PWM signal is initiated to turn on the high-side FET for a fixed on-time. The floor voltage is generated from an internal





Theory of Operation

compensated error amplifier, which compares the Vout with a reference voltage. As shown in Figure 16, the output sense pins VOSENP and VOSENM are connected across the output capacitors.

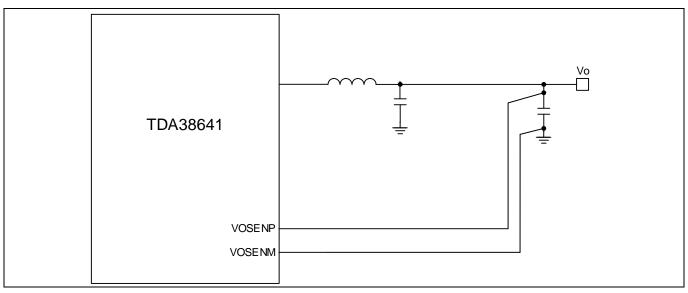


Figure 16 Output voltage sensing connections

14.12 **VRRDY**

VRRDY is Intel's equivalent of PGOOD. The electrical characteristics for the signal are defined in detail in the Intel VR14 PWM document. It is an open drain output pulled up to 3.3 V. When the power-on sequence is initiated, and with VBOOT set to > 0V, the output voltage will ramp to its configured boot voltage and assert VRRDY. In case of fault the response of the VRRDY pin in shown in Table 16.

Table 16 VRRDY Response to Faults

Type of Fault	VRRDY Pin Functionality	Device Behavior after event
OVP	This pin is de-asserted	Latched Shutdown
ОСР	This pin is de-asserted	Latched Shutdown
UVP	This pin is de-asserted	Latched Shutdown
Boot UVLO	This pin is de-asserted	Latched Shutdown
Vcc UVLO	This pin is de-asserted	Latched Shutdown
ОТР	This pin is de-asserted	Latched Shutdown

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Faults and Protection

15 Faults and Protection

15.1 Over Current Protection (OCP)

The TDA38641 has two types of OCP protection: Analog OCP (AOCP) and Digital OCP (DOCP). The AOCP current limit is based on inductor valley current, whereas the DOCP is based on average current information. AOCP is a fast fault response, and should be set to a value that prevents failure of the device.

A novel scheme allows reconstruction of the inductor current from the voltage sensed across the Sync FET RDS(on). It should be noted here that it is this reconstructed average inductor current that is digitized by the ADC and used for output current reporting and for DOCP operation.

The AOCP fault protection circuit also uses the voltage sensed across the RDS(on) of the Synchronous MOSFET; however, the protection mechanism relies on a fast comparator to compare the sensed signal to the over current threshold and does not depend on the ADC or reported current. Hence AOCP has a fast fault response. The current limit scheme uses an internal temperature compensated current source that has the same temperature coefficient as the RDS(on) of the Synchronous MOSFET. As a result, the over current trip threshold remains almost constant over temperature.

In test mode for TDA38641, AOCP level can be accessed via three bits in the register map (aocp_thresh_sel [2:0]). The digital OCP (DOCP) is available via the PMBus register IOUT_OC_FAULT_LIMIT. When the part is not in test mode, both the AOCP and DOCP levels are set by the pin strap resistor on ILIM pin. The response to the fault is decided by IOUT_OC_FAULT_RESPONSE. Available responses are shutdown, latch off and retry. The indication of the fault is accessible available in the STATUS_IOUT register in PMBus.

AOCP shall be enabled during soft-start and normal operation including FCCM and DEM modes. When the AOCP threshold is crossed, the low side MOSFET will continue to stay on for the remaining cycle and the following high side pulse will be ignored to allow inductor relaxation (pulse skipping). If an AOCP condition is detected on the rising edge of a PWM pulse, the high side will still be blocked from turning on and the pulse will be skipped. The high-side will continue to be ignored if the current remains above the AOCP threshold. When current falls below the AOCP threshold, the following high-side pulse will be enabled. The Vout under AOCP is determined by the overload on the output and that determines if the VRRDY gets de-asserted or the UVP protection is triggered as a result of AOCP.

Current signal for the DOCP protection is passed through a 5.5KHz filter, before being compared with the IOUT_OC_FAULT_LIMIT threshold. Hence the response of the DOCP circuit is slower than AOCP due to the averaging of the current signal by the filter. The DOCP threshold operating point can be calibrated by IOUT_CAL_GAIN and IOUT_CAL_OFFSET. Because of the averaging of the current signal, DOCP is more accurate than AOCP. It is recommended to set AOCP higher than DOCP as AOCP may get triggered earlier than DOCP and may result in drop in output voltage when both AOCP and DOCP are set to same value. When the Digital OCP is triggered from the Analog OCP using docp_from_aocp register 0x60[3], a 10-count counter is implemented to count 10 AOCP events, then a signal is sent to the digital block to perform the programmed response. The counter is reset after 3 consecutive non-OCP events. The count occurs at the valley of the current. Note that COT switching frequency will decrease when skipping pulses. Figure 17 is an example AOCP response.

The TDA38641 also offers cycle-by-cycle AOCP response with a choice of eight selectable current limits, which is set by the resistance at ILIM pin (Section 8). The selected OCP limit bank is loaded to the IC during the power up and cannot be changed on the fly. To change the OCP limit, users must cycle the EN signal or VCC voltage. Cycle-by-cycle OCP response allows the TDA38641 to fulfill a brief high current demand, such as a high inrush current during the startup. The output slew rate and the output capacitance will affect the AOCP during startup. At higher output voltages with no-load, a higher output slew rate or a higher output capacitance can falsely trigger AOCP at startup. The TON_RISE time should be increased or output capacitance should be reduced to avoid false triggering of AOCP.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Faults and Protection

The AOCP is activated when the EN voltage is above its threshold. During AOCP events, the valley of the inductor current is regulated around the AOCP limit. But during the first switching cycle when the AOCP is tripped, the valley of the inductor current can drop slightly below the AOCP limit. It should be noted that AOCP events do not pull the VRRDY signal low unless the output voltage eventually drop below the Under-Voltage Protection (UVP) threshold and trigger UVP. The response is also shown in Figure 17.

The OCP limits are thermally compensated. The corresponding output dc current can be calculated as follows:

$$I_{out_OCP} = I_{LIM} + \frac{\Delta i_L}{2}$$

Where: I_{out_OCP} = Output dc current when AOCP is tripped. I_{LIM} = AOCP limit, which is the valley of inductor current. ΔiL = Peak-peak inductor ripple current.

To avoid inductor saturation during AOCP events, the following criterion is recommended for the inductor saturation current rating.

$$I_{sat} \ge I_{LIM\ max} + \Delta i_L$$

Where: I_{sat} is the inductor saturation current and I_{LIM_max} is the maximum spec of the AOCP limit.

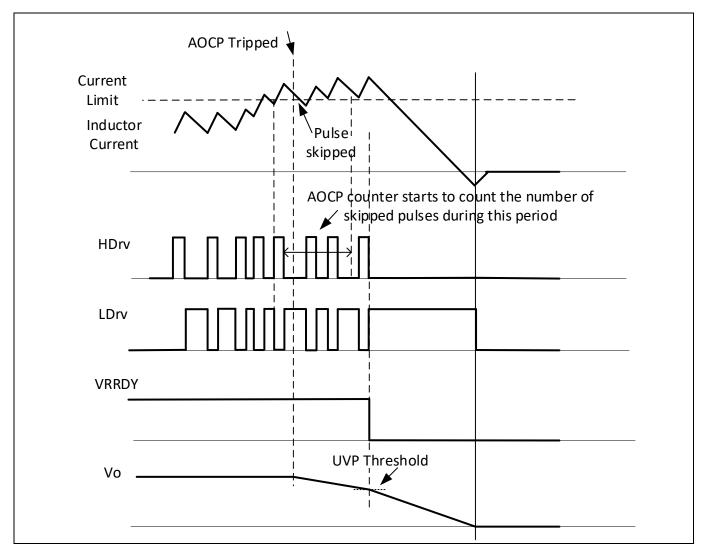


Figure 17 AOCP response timing diagram.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Faults and Protection

15.2 Output Under Voltage Protection (UVP)

The TDA38641 UVP response is a relative limit configurable from 50 mV to 400 mV in steps of 50 mV. The limit is programmed via VBT pin (Section 8). In test mode, it can be done using the VOUT_UV_FAULT_LIMIT PMBus command, and the response is programmed via the VOUT_UV_FAULT_RESPONSE command or utilize the option to program the UVP Limit for the part by accessing the I2C register in the common regmap space. The UVP threshold is enabled using the relative_uvp_thresh_en (0x5E [15]) bit and the levels are set by the relative_uvp_thresh [2:0] (0x5E [10:8]) bits. Possible responses are ignore, shutdown, and retry indefinitely. The relative UVP may be disabled using the disable_relative_UVP(0x60[14]) bit.

When the UVP fault is triggered, a flag is raised and the part is tri-stated until the flag is cleared using the PMBus CLEAR_FAULTS command and the part is started again by either cycling the Vcc or the EN signal to the part. The shutdown response entails tri-stating both the MOSFET's and discharging the output either via a bleed resistor at the output or through the body diode of the low side FET.

If the response is set to retry, a user defined timer (1 ms to 8 ms in steps of 1 ms) is started as soon as the UVP fault is triggered, and the output is tri-stated. At the end of the timer the output is checked against a fixed level of 250 mV. If the output is below this voltage the startup sequence is initiated or else the timer is reset and the output tri-state continues (both the MOSFET's are tri-stated).

There are options for UVP protection to be lifted during voltage transitions (Vboot, DVID up and/or down) using the register bits blank_uv_sel [1:0]. The options for this register are outlined in Table 17.

Table 17 Optional UVP blanking via register blank_uv_sel (0x60[11:10]) available in test mode only

sel	Description
3	blank UV faults during DVID up or down (including Vboot)
2	blank UV faults during DVID up (including Vboot)
1	blank UV faults during Vboot
0	no UV fault blanking

15.3 Over Voltage Protection (OVP)

The OVP response is divided into two parts: Fixed OVP (FOVP) and Relative OVP (ROVP). The Fixed OVP is typically used for startup, all DVIDs, and when EN is low. ROVP covers all other situations during operation. Figure 18 depicts an example of when FOVP and ROVP are utilized.

When using the VBT pin (Section 8) to set the output voltage, the VOUT_COMMAND value should be the same as the VBT pin strap setting to avoid improper ROVP triggering.

The FOVP has 8 distinct levels (0.8 V, 1 V, 1.2 V, 1.35 V, 1.5 V, 1.8 V, 2.2 V, and 2.85 V) with VOUT_SCALE_LOOP in 1:1 mode. The levels are doubled in VOUT_SCALE_LOOP 1:2 mode. The Fixed OVP and ROVP are set by the VBT pin in the part. However, in test mode it is programmable via fixed_ovp_thresh [2:0] in configuration register 0x60. The response to an OVP event is programmed via the VOUT_OV_FAULT_RESPONSE command. OVP can have four responses: ignore, shutdown, and retry n (max 6) times after n (defined by PMBus) seconds before latching and retry forever. The threshold for ROVP is relative to the programmed output voltage and can be set from 50 mV to 400 mV in steps of 50 mV using the I2C register relative_ovp_thresh [2:0] (0x5e [14:12]). The OVP fault can also be blanked by using the bits [13:12] of register 0x60 in common regmap space. Please refer to Table 14 for more details. The PMBUs commands could be over-ridden by using the relative_ovp_thresh_en (0x5e [15]) bit to over-ride the PMBUs commands.

Table 18 Optional OVP blanking via blank_ov_sel(0x60[13:12]) available only in test mode





Faults and Protection

sel	Description
3	blank OV faults during DVID up or down (including Vboot)
2	blank OV faults during DVID up (including Vboot)
1	blank OV faults during Vboot
0	no OV fault blanking

When the output triggers an FOVP event, the OVP flag is set, the low side switch is turned ON and the high side switch is turned OFF. The low side switch is turned ON till the output voltage is dragged down to the set FOVP threshold. The output voltage then decreases to zero with its natural decay.

When the output triggers an ROVP event, the VID set point is moved to 0.25 V at a controlled slew rate of 30 mV/uS and the OVP flag is set. Next, the low side switch is turned ON and the high side is turned OFF. This allows the output to discharge until VID set point reaches zero or Vout catches up with the VID set point at which point the low side and high side switched turn ON and OFF as required to maintain the output at the VID set point. How fast the output voltage discharges during this event is determined by the by the output voltage, output capacitance and output inductor. This determines if the output voltage indeed is dragged down to zero by the end of the controlled VID ramp down. At the end of the ramp, if the output is not already dragged down to zero, the output voltage will decrease to zero with its natural decay.

The picture below shows an example of how ROVP and RUVP work during DVID changes in conjuction with blank settings mentioned above. In this example, the ROVP is blanked during the DVID down and Vboot

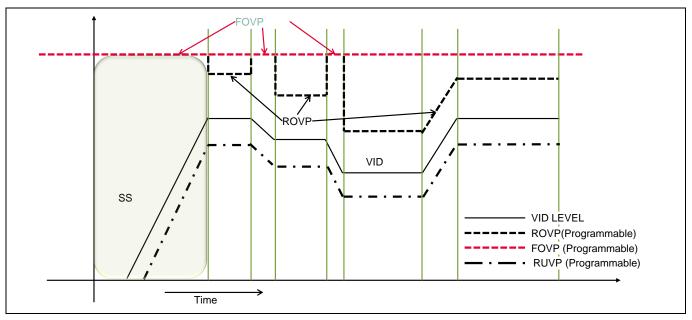


Figure 18 OVP and RUVP example diagram. Note the situations in which FOVP takes over from ROVP.

15.4 Over Temperature Protection (OTP)

Temperature protection is programmable via the OT_FAULT_LIMIT, OT_WARN_LIMIT, and OT_FAULT_RESPONSE PMBus registers. The TDA38641 supports three responses: ignore, shutdown, and retry indefinitely. The fault is non-latching.

An OTP event is triggered when the device temperature reaches the OT_FAULT_LIMIT. The switching output is tristated and the output discharges, while staying biased with the internal LDO on. With the output off, the device cools until reaching the OT_WARN_LIMIT, and if set to retry, the device will hiccup with potential of pre-biased startup. For this part the OT_FAULT_LIMIT is set to 140°C by default with a 20°C hysteresis.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Faults and Protection

15.5 Boot Under Voltage Lockout (UVLO)

The voltage from the BOOT pin to PHASE pin is monitored on the TDA38641. If the UVLO Boot lower threshold violation is detected within the PWM cycle, the event is counted and a fault is asserted after 10 violations. After 3 consecutive cycles without a UVLO BOOT event (above the lower threshold during the PWM cycle), the counter resets. To clear the fault, Vcc or EN has to be cycled. The Boot UVLO fault is in the fail_code_sticky register.

15.6 Minimum On - Time and Minimum Off - Time

The minimum on-time refers to the shortest time for Control MOSFET to be reliably turned on. The minimum off-time refers to the minimum time duration in which the Synchronous FET stays on before a new PWM pulse is generated. The minimum off-time is needed for TDA38641 to charge the bootstrap capacitor, and to sense the current of the Synchronous MOSFET for OCP.

For applications requiring a small duty cycle, it is important that the selected switching frequency results in an ontime larger than the maximum spec of the minimum on-time in the Section 7.1. Otherwise the resulting switching frequency may be lower than the desired target. The following formula could be used to check for the minimum on-time requirement.

$$\frac{V_0}{kf_{sw} \times V_{in}} > \max spec of T_{on(min)}$$

Where f_{sw} is the desired switching frequency, and k is the variation of the switching frequency. As a rule of thumb, select k = 1.25 to ensure the design margin.

For applications requiring a high duty cycle, it is important to make sure a proper switching frequency is selected so that the resulting off-time is longer than the maximum spec of the minimum off-time in the Section **6**, which can be calculated as shown below.

$$\frac{V_{in} - V_0}{kf_{sw} \times V_{in}} > \max spec of T_{off(min)}$$

Where f_{sw} is the desired switching frequency, and k is the variation of the switching frequency. As a rule of thumb, select k = 1.25 to ensure the design margin.

The resulting maximum duty cycle is therefore determined by the selected on-time and minimum off-time.

$$D_{max} = \frac{T_{on}}{T_{on} + T_{off(\min)}}$$

15.7 High-Side Short (HSS) Detection

The TDA38641 offers high-side FET short detection. The phase pin is monitored when the low-side FET is active. HSS monitoring happens both at startup and during normal operation. In an HSS event, the HSS threshold is reached and VRRDY is asserted. Once the HSS threshold is reached, the low-side FET is turned on and the switching stops. There is no current reporting during this time. The fault is sticky and only clears when either the VCC or EN signal is cycled.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Fault Communication

16 Fault Communication

The TDA38641 supports OCP, OVP, UVP, OTP, BOOT UVLO, and Vcc UVLO via telemetry in test mode only.

16.1 Real-Time Telemetry in

In the SVID domain, the TDA38641 supports output voltage, output current, input voltage, input current, and input power telemetry.

16.2 PMBus Commands Supported

Table 19 lists all the PMBus commands which are supported by the device in test mode.

Table 19 PMBus Commands Supported

I2C Register Address	COMMAND	PMBus PROTOCOL	PMBus COMMAND CODE	DESCRIPTION
0x200	PAGE	Read/Write Byte	00h	Allows access of each loop via paging.
0x202	OPERATION	Read/Write Byte	01h	Enables or disables the output and controls margining. Ignores OVP on Margin High, UVP on Margin Low.
0x204	ON_OFF_CONFIG	Read/Write Byte	02h	Configures the combination of CONTROL pin and OPERATION command needed to turn the unit on and off.
0x206	CLEAR FAULTS	Send Byte	03h	Clear contents of Fault registers
0x20A	PAGE_PLUS_WRITE	Write Block	05h	Set the PAGE within a device, send a command, and send the data for the command in one packet.
0x20C	PAGE_PLUS_READ	Block Read	06h	Set the PAGE within a device, send a command, and read the returned data by the command in one packet
0x220	WRITE_PROTECT	Read/Write Byte	10h	Protects from overwriting the configuration files and modes accidentally
0x222	STORE_DEFAULT_ALL	Send Byte	11h	Instructs the device to copy the entire contents of the configuration registers to the NVM
0x224	RESTORE_DEFAULT_ALL	Send Byte	12h	Reloads the OTP
0x22A	STORE_USER_ALL	Send Byte	15h	Stores the user OTP section
0x22C	RESTORE_USER_ALL	Send Byte	16h	Reloads the user OTP section
0x232	CAPABILITY	Read Byte	19h	Returns 1010xxxx to indicate Packet Error Checking is supported and Maximum bus speed is 400kHz
0x236	SMBALERT_MASK	Block Write/ Block Read Process Call	1Bh	Set to prevent warning or fault conditions from asserting the SMBALERT# signal. Write command code for STATUS register to be masked in the low byte, the bit to be masked in the High byte.
0x240	VOUT_MODE	Read/Write Byte	20h	Sets the format for VOUT related commands.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



I2C Register Address	COMMAND	PMBus PROTOCOL	PMBus COMMAND CODE	DESCRIPTION
				Linear mode, -8, -9, and -12 exponents supported.
0x242	VOUT_COMMAND	Read/Write Word	21h	Sets the voltage to which the device should set the output. Format according to VOUT_MODE. Resolution is 5mV when the IC Vout is configured with a load line. Resolution is 5mV or 0.625 mV when the IC is configured without a load line.
0x248	VOUT_MAX	Read/Write Word	24h	Sets an upper limit on the output voltage the unit can command. Format according to VOUT_MODE.
0x24A	VOUT_MARGIN_HIGH	Read/Write Word	25h	Sets the margin high voltage when commanded by OPERATION. Must be in format determined by VOUT_MODE.
0x24C	VOUT_MARGIN_LOW	Read/Write Word	26h	Sets the margin low voltage when commanded by OPERATION. Must be in format determined by VOUT_MODE.
0x24E	VOUT_TRANSITION_RATE	Read/Write Word	27h	Sets the rate at which the output changes voltage due to VOUT_COMMAND or OPERATION commands.
0x250	VOUT_DROOP	Read/Write Word	28h	Allows the user to set the load-line value in resolution of $5/256\Omega$. Exponent is 1
0x252	VOUT_SCALE_LOOP	Read/Write Word	29h	Used to account for any external attenuation network on VOUT sense feedback and provide correct VOUT reporting.
0x256	VOUT_MIN	Read/Write Word	2Bh	Sets a lower limit on the commanded output voltage. Format according to VOUT_MODE
0x266	FREQUENCY_SWITCH	Read/Write Word	33h	Sets the switching frequency in kHz per table found in user note UN0047. Exp = 0, 1
0x26A	VIN_ON	Read/Write Word	35h	Sets the value of the input voltage at which the unit should begin power conversion. Exp = -1.
0x26C	VIN_OFF	Read/Write Word	36h	Sets the value of the input voltage at which the unit, once operation has started, should stop power conversion. Exp = -1.
0x270	IOUT_CAL_GAIN	Read/Write Word	38h	Used to calibrate the output current's gain
0x272	IOUT_CAL_OFFSET	Read/Write Word	39h	Used to null out any offsets in the output current sensing circuitry. Exp = 2.
0x280	VOUT_OV_FAULT_ LIMIT	Read/Write Only	40h	Returns the value of the output voltage, measured at the sense or output pins, that causes an output over voltage fault.
0x282	VOUT_OV_FAULT_ RESPONSE	Read/Write Byte	41h	Instructs the device on what action to take in response to an output over voltage

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



I2C Register Address	COMMAND	PMBus PROTOCOL	PMBus COMMAND CODE	DESCRIPTION
				fault. Only shutdown and ignore are supported.
0x288	VOUT_UV_FAULT_ LIMIT	Read/Write Only	44h	Returns the value of the output voltage, measured at the sense or output pins, that causes an output undervoltage fault.
0x28A	VOUT_UV_FAULT_ RESPONSE	Read/Write Byte	45h	Instructs the device on what action to take in response to an output undervoltage fault. Only shutdown and ignore are supported.
0x28C	IOUT_OC_FAULT_ LIMIT	Read/Write Word	46h	Sets the value of the output current, in amperes, that causes the over current detector to indicate an over current fault condition. Set by writing this command in Linear format with a -1 exponent.
0x28E	IOUT_OC_FAULT_ RESPONSE	Read/Write Byte	47h	Instructs the device on what action to take in response to an output over current fault. Only C0h (shutdown immediately), F8h (hiccup forever), and D8 (hiccup 3 times) are supported.
0x29E	OT_FAULT_LIMIT	Read/Write Word	4Fh	Sets the temperature, in degrees Celsius, of the unit at which it should indicate an over temperature fault. Exp = 0.
0x2A0	OT_FAULT_RESPONSE	Read/Write Byte	50h	Instructs the device on what action to take in response to an over temperature fault. Only shutdown and ignore are supported.
0x2A2	OT_WARN_LIMIT	Read/Write Word	51h	Sets the temperature, in degrees Celsius, of the unit at which it should indicate an over temperature Warning alarm. Exp = 0.
0x2AA	VIN_OV_FAULT_LIMIT	Read/Write Word	55h	Sets the value of the input voltage that causes an input over voltage fault. Exp = -4.
0x2AC	VIN_OV_FAULT_RESPONSE	Read/Write Byte	56h	Instructs the device on what action to take in response to an input over voltage fault. Only shutdown and ignore are supported.
0x2BC	POWER_GOOD_ON	Read/Write Word	5Eh	Sets the output voltage at which an optional POWER_GOOD signal should be asserted. Format according to VOUT_MODE.
0x2BE	POWER_GOOD_OFF	Read/Write Word	5Fh	Sets the output voltage at which an optional POWER_GOOD signal should be negated. Format according to VOUT_MODE.
0x2C0	TON_DELAY	Read/Write Word	60h	Sets the time, in milliseconds, from when a start condition is received (as programmed by the ON_OFF_CONFIG

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



I2C Register Address	COMMAND	PMBus PROTOCOL	PMBus COMMAND CODE	DESCRIPTION
				command) until the output voltage starts to rise. Exp = 0.
0x2C2	TON_RISE	Read/Write Word	61h	Sets the time, in milliseconds, from when the output starts to rise until the voltage has entered the regulation band. Exp = 0.
0x2C8	TOFF_DELAY	Read/Write Word	64h	Sets the time (in ms) from when a stop condition is received (as programmed by the ON_OFF_CONFIG command) until the unit stops transferring energy to the output. Exp = 0.
0x2CA	TOFF_FALL	Read/Write Word	65h	Sets the time, in milliseconds, from the end of the turn-off delay time until the voltage is commanded to zero. Not supported. Exp = 0.
0x2F0	STATUS_BYTE	Read/Write Byte	78h	Returns 1 byte where the bit meanings are: Bit <7> Reserved Bit <6> Output off (due to fault or enable) Bit <5> Output over voltage fault Bit <4> Output over current fault Bit <3> Input under voltage fault Bit <2> Temperature fault Bit <1> Communication/Memory/Logic fault Bit <0>: None of the Above
0x2F2	STATUS_WORD	Read/Write Word	79h	Returns 2 bytes where the Low byte is the same as the STATUS_BYTE data. The High byte has bit meanings are: Bit <7> Output high or low fault Bit <6> Output over current fault Bit <5> Input voltage or current fault. Bit <4> MFR_SPECIFIC Bit <3> POWR GOOD# Bit <2:0> Not Supported
0x2F4	STATUS_VOUT	Read/Write Byte	7Ah	Bit <7> Output over voltage Fault Bit <6> Not Supported Bit <5> Not Supported Bit <4> Output Undervoltage Fault Bit <3> VOUT_MAX Warning Bit <2:0> Not Supported
0x2F6	STATUS_IOUT	Read/Write Byte	7Bh	Bit <7> Output over current Fault Bit <6> Not Supported Bit <5> Output over current Warning Bit <4:0> Not Supported

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



I2C Register Address	COMMAND	PMBus PROTOCOL	PMBus COMMAND CODE	DESCRIPTION
0x2F8	STATUS_INPUT	Read/Write Byte	7Ch	Bit <7> Input over voltage Fault Bit <6:0> Not Supported
0x2FA	STATUS_TEMPERATURE	Read/Write Byte	7Dh	Bit <7> Over temperature Fault Bit <6> Over temperature Warning Bit <5:0> Reserved
0x2FC	STATUS_CML	Read/Write Byte	7Eh	Returns 1 byte where the bit meanings are: Bit <7> Invalid or unsupported command Bit <6> Invalid or unsupported data Bit <5> PEC fault Bit <4:2> Reserved Bit <1> Other communication fault not listed here Bit <0> Reserved
0x310	READ_VIN	Read Word	88h	Returns the input voltage in Volts
0x312	READ_IIN	Read Word	89h	Returns the input current in Amperes
0x316	READ_VOUT	Read Word	8Bh	Returns the output voltage in the format set by VOUT_MODE
0x318	READ_IOUT	Read Word	8Ch	Returns the output current in Amperes
0x31A	READ_TEMPERATURE_1	Read Word	8Dh	Returns the addressed loop NTC temperature in degrees Celsius
0x32C	READ_POUT	Read Word	96h	Returns the output power in Watts
0x32E	READ_PIN	Read Word	97h	Returns the input power in Watts
0x330	PMBUS_REVISION	Read Byte	98h	Reports PMBus Part I rev 1.1 & PMBUs Part II rev 1.2(draft)
0x332	MFR_ID	Block Read/Write Byte count = 2	99h	The MFR_ID is set to IF (HEX 4946) unless programmed differently in the USER registers of the controller.
0x334	MFR_MODEL	Block Read/Write, Byte count = 2	9Ah	The MFR_MODEL is the same as the device ID if the USER register for Manufacturer model is 00. Otherwise MFR_Model command returns the value in the USER register for MFR_MODEL.
0x336	MFR_REVISION	Block Read/Write, Byte count = 2	9Bh	The MFR_REVISION is the same as the device revision if the USER register for Manufacturer revision is 00. Otherwise MFR_REVISION command returns the value in the USER register for MFR_REVISION.
0x35A	IC_DEVICE_ID	Block Read	ADh	Returns a 1-byte code with the following values: A7h = TDA38641. Note 17
0x35C	IC_DEVICE_REV	Block Read	AEh	The IC revision that is stored inside the IC
0x382	MFR_VENDOR_INFO_1	Read Word, Byte count = 2	C1h	Returns the product_id and silicon revision
0x384	MFR_VENDOR_INFO_2	Read/Write Word	C2h	Available for vendor use





Fault Communication

I2C Register Address	COMMAND	PMBus PROTOCOL	PMBus COMMAND CODE	DESCRIPTION
		Byte count = 2		
0x3A0	MFR_READ/WRITE_ REG	Custom MFR protocol	D0h	Read/Write I2C registers

Note:

17. Previous revision silicon has Device ID 83h. Please refer to datasheet version 2.2 for previous silicon

16.3 11-BIT Linear Data Format

Monitored parameters use the Linear Data Format (Figure 24) encoding into 1 Word (2 bytes), where:

$$Value = Y * 2^N$$

Note N and Y are "signed" values. If VOUT is set to linear format (by VOUT_MODE), then N is set by the VOUT_MODE command and only Y is returned in the data-field as a 16-bit unsigned number.

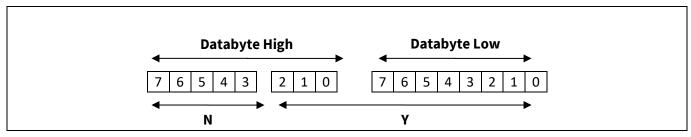


Figure 19 11-Bit Linear Data Format

16.4 16-BIT Linear Data Format

This format is only used for VOUT related commands (READ_VOUT, VOUT_COMMAND, VOUT_MARGIN_HIGH, VOUT_MARGIN_LOW, POWER_GOOD_ON, and POWER_GOOD_LOW):

$$Value = Y * 2^N$$

Note N and Y are "signed" values. If VOUT is set to linear format (by VOUT_MODE), then N is set by the VOUT_MODE command and only Y is returned in the data-field as a 16-bit unsigned number.

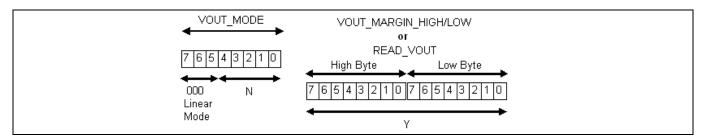


Figure 20 16-BIT Linear Data Format

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Fault Communication

16.5 SVID Registers

A list of all the SVID registers is given in Table 20. SVID registers supported by the TDA38641 in VR12.5, VR13, and VR13.HC mode conform to VR12.5, VR13, and VR13.HC specifications respectively.

Table 20 SVID Registers

Register Address	Register Name	Access	VR12.5 Mode	VR13 Mode	VR14 Mode
00	Vendor ID	RO	Supported	Supported	Supported
01	Product ID	RO	Supported	Supported	Supported
02	Product Revision	RO	Supported	Supported	Supported
03	Product Date Code	-	Not Supported	Not Supported	Not Supported
04	Lot Code	-	Not Supported	Not Supported	Not Supported
05	Protocol ID	RO	Supported	Supported	Supported
06	Capability	RO	Supported	Supported	Supported
07	Step Size	RO	Not Supported	Not Supported	Not Supported
07	Vendor Use	RW	Not Supported	Not Supported	Not Supported
08	Bias VID Table	RO	Not Supported	Not Supported	Not Supported
09	VIDOMAX_H_CAPA	RO	Not Supported	Not Supported	Supported
0A	VIDOMAX_L	RO	Not Supported	Not Supported	Supported
0B	VIN_FULLSCALE_H	RO	Not Supported	Not Supported	Not Supported
0C	VIN_FULLSCALE_L	RO	Not Supported	Not Supported	Not Supported
0D	VOUT_FULLSCALE_H	RO	Not Supported	Not Supported	Supported
0E	VOUT_FULLSCALE_L	RO	Not Supported	Not Supported	Supported
0F	ALLCALL_ACT	RW	Not Supported	Not Supported	Supported
10	Status_1	RO	Supported	Supported	Supported
11	Status_2	RO	Supported	Supported	Supported
12	Temperature	RO	Supported	Supported	
13	PMIC_GLOBAL_ST	RO	Not Supported	Not Supported	Not Supported

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Register Address	Register Name	Access	VR12.5 Mode	VR13 Mode	VR14 Mode
14	LASTREAD	RO	Not Supported	Not Supported	Supported
15	IOUT_H	RO	Supported	Supported	Supported
16	VOUT_H	RO	Supported	Supported	Supported
17	VR Temperature	RO	Supported	Supported	Supported
18	Output Power	RO	Supported	Supported	Supported
19	Input Current	RO	Not Supported	Not Supported	Not Supported
1A	Input Voltage	RO	Not Supported	Not Supported	Not Supported
1B	Input Power	RO	Not Supported	Not Supported	Not Supported
1C	Status 2 Last Read	RO	Supported	Supported	Supported
1D	PARERR_CNT	RO	Not Supported	Not Supported	Not Supported
1E	CFG_FILE_ID	RO	Not Supported	Not Supported	Supported
1F	Future Command	-	Not Supported	Not Supported	Not Supported
20	ICC IN Max	RO	Not Supported	Not Supported	Not Supported
21	ICC Max	RO	Supported	Supported	Supported
22	Temp Max	RO	Not Supported	Supported	Supported
23	DC_LL	RO	Not Supported	Not Supported	Not Supported
24	SR_Fast	RO	Supported	Supported	Supported
25	SR_Slow	RO	Supported	Supported	Supported
26	Vboot	RO	Supported	Supported	Supported
27	VR Tolerance	-	Not Supported	Not Supported	Not Supported
28	Current-Offset	RW	Not Supported	Not Supported	Not Supported
29	Temperature Offset	RW	Not Supported	Not Supported	Not Supported
2A	Slow Slew Rate Select	RW	Not Supported	Supported	Supported
2B	PS4 Exit Latency	RO	Not Supported	Not Supported	Supported
2C	PS3 Exit Latency	RO	Not Supported	Not Supported	Supported
2D	Enable to Ready	RO	Not Supported	Not Supported	Supported

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Register Address	Register Name	Access	VR12.5 Mode	VR13 Mode	VR14 Mode
2E	Pin Max	RO	Not Supported	Not Supported	Not Supported
2F	Pin Alert Threshold	RW	Not Supported	Not Supported	Not Supported
30	V _{OUT} Max	RW	Supported	Supported	Supported
31	VID Setting	RW	Supported	Supported	Supported
32	Pwr State	RW	Supported	Supported	Supported
33	Offset	RW	Supported	Supported	Supported
34	Multi VR Config	RW	Supported	Supported	Supported
35	MAIN_ADDR_PTR	RW	Not Supported	Not Supported	Not Supported
36	DC_LL_FINE	RO	Not Supported	Not Supported	Not Supported
37	Future Command	-	Not Supported	Not Supported	Not Supported
38	Future Command	-	Not Supported	Not Supported	Not Supported
39	Future Command	-	Not Supported	Not Supported	Not Supported
3A	Work Point 0	RW	Not Supported	Supported	Supported
3B	Work Point 1	RW	Not Supported	Supported	Supported
3C	Work Point 2	RW	Not Supported	Supported	Supported
3D	Work Point 3	RW	Not Supported	Supported	Supported
3E	Work Point 4	RW	Not Supported	Not Supported	Not Supported
3F	Work Point 5	RW	Not Supported	Not Supported	Not Supported
40	Work Point 6	RW	Not Supported	Not Supported	Not Supported
41	Work Point 7	RW	Not Supported	Not Supported	Not Supported
42	IVID1-VID	RW	Not Supported	Not Supported	Not Supported
43	IVID1-I	RW	Not Supported	Not Supported	Not Supported
44	IVID2-VID	RW	Not Supported	Not Supported	Not Supported
45	IVID2-I	RW	Not Supported	Not Supported	Not Supported

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Register Address	Register Name	Access	VR12.5 Mode	VR13 Mode	VR14 Mode
46	IVID3-VID	RW	Not Supported	Not Supported	Not Supported
47	IVID3-I	RW	Not Supported	Not Supported	Not Supported
50	HIGH_PWR	RO	Not Supported	Not Supported	Supported
51	PWRSTATE_SUP	RO	Not Supported	Not Supported	Supported
52	PHSHED_SUP	RO	Not Supported	Not Supported	Supported
53	PHSHED_ACT	RW	Not Supported	Not Supported	Supported
54	NEGVREN_SUP	RO	Not Supported	Not Supported	Supported
55	NEGVREN_ACT	RW	Not Supported	Not Supported	Supported
56	DIGOUT_STATUS	RO	Not Supported	Not Supported	Not Supported
57	WP_SLEW_0	RW	Not Supported	Not Supported	Supported
58	WP_SLEW_1	RW	Not Supported	Not Supported	Supported
59	WP_SLEW_2	RW	Not Supported	Not Supported	Not Supported
5A	WP_SLEW_3	RW	Not Supported	Not Supported	Not Supported
5B	WP_SLEW_TT	RW	Not Supported	Not Supported	Supported
60	CAL_CAPABILITY	RO	Not Supported	Not Supported	Not Supported
61	CAL_REQUEST	WT	Not Supported	Not Supported	Not Supported
62	CAL_IMAG_A	RW	Not Supported	Not Supported	Not Supported
63	CAL_IMAG_B	RW	Not Supported	Not Supported	Not Supported
64	CAL_STATUS	RO	Not Supported	Not Supported	Not Supported
70	EXP_ACCURACY	RO	Not Supported	Not Supported	Not Supported
71	IOUT_L	RO	Not Supported	Not Supported	Not Supported
72	VOUT_L	RO	Not Supported	Not Supported	Not Supported

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Register Address	Register Name	Access	VR12.5 Mode	VR13 Mode	VR14 Mode
73	POUT_L	RO	Not Supported	Not Supported	Not Supported
74	IIN_L	RO	Not Supported	Not Supported	Not Supported
75	VIN_L	RO	Not Supported	Not Supported	Not Supported
76	PIN_L	RO	Not Supported	Not Supported	Not Supported
77	PSYS_CR_LVL_L	RW	Not Supported	Not Supported	Not Supported
78	PSYS_W2_LVL_L	RW	Not Supported	Not Supported	Not Supported
79	PSYS_W1_LVL_L	RW	Not Supported	Not Supported	Not Supported
7A-BF	RESERVED		Not Supported	Not Supported	Not Supported
C0-FF	VENDOR_RESERVED	RW	Not Supported	Not Supported	Not Supported

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Design example

17 Design example

In this section, an example is used to explain how to design a buck regulator with the TDA38641. The design specifications are given below.

- PV_{in} = 12 V (±10%)
- V_o = 1.0 V
- I_o = 40 A
- V_o ripple voltage = ±1% of V_o
- Load transient response = $\pm 3\%$ of V_0 with a step load current = 9 A and slew rate = 30 A/ μ s

17.1 Enabling the TDA38641

The TDA38641 has a precise Enable threshold voltage, the Enable feedback resistor, R_{EN1} and R_{EN2} , can be calculated as follows.

$$PV_{in(\min)} \times \frac{R_{EN2}}{R_{EN1} + R_{EN2}} \ge V_{EN(\max)}$$

$$R_{EN2} \geq R_{EN1} \times \frac{V_{EN(\text{max})}}{PV_{in(\text{min})} - V_{EN(\text{max})}}$$

Where $V_{EN(max)}$ is the maximum spec of the EN-start-threshold as defined in the Absolute Maximum Ratings table. For $PV_{in\ (min)}$ = 10.8 V, select R_{EN1} =49.9 k Ω and R_{EN2} > 3.4k Ω . R_{EN2} suggested is 7.5 k Ω .

17.2 Programming the Switching Frequency and Operation Mode

The TDA38641 has very good efficiency performance and is suitable for high switching frequency operation. In this case, 800 kHz is selected to achieve a good compromise between efficiency, passive component size and dynamic response. In addition, FCCM operation is selected to ensure a small output ripple voltage over the entire load range. 800 kHz switching frequency and FCCM operation can be selected via ILIM and TON/MODE pins.

17.3 Selecting Input Capacitors

Without input capacitors, the pulse current of Control MOSFET is provided directly from the input supply power. Due to the impedance on the cable, the pulse current can cause disturbance on the input voltage and cause potential EMI issues. The input capacitors filter the pulse current, resulting in almost constant current from the input supply. The input capacitors should be selected to tolerate the input pulse current, and to reduce the input voltage ripple. The RMS value of the input ripple current can be expressed by:

$$I_{RMS} = I_o \times \sqrt{D \times (1 - D)}$$

$$D = \frac{V_o}{PV_{in}}$$

Where I_{RMS} is the RMS value of the input capacitor current. I_o is the output current and D is the Duty Cycle. For I_o = 40A and $D_{(max)}$ = 0.09, the resulting RMS current flowing into the input capacitor is I_{rms} = 11.6 A.

To meet the requirement of the input ripple voltage, the minimum input capacitance can be calculated as follows.

$$C_{in(\min)} > \frac{I_o \times (1-D) \times D}{f_{sw} \times (\Delta PV_{in} - ESR \times I_o \times (1-D))}$$

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Design example

Where ΔPV_{in} is the maximum allowable peak-to-peak input ripple voltage, and ESR is the equivalent series resistance of the input capacitors. Ceramic capacitors are recommended due to low ESR, ESL and high RMS current capability. For I_0 = 40 A, f_{sw} = 800 kHz, ESR = 3 m Ω , and ΔPV_{in} = 240 mV, $C_{in(min)}$ > 32 μF . To account for the derating of ceramic capacitors under a bias voltage, 10 x 22 $\mu F/0805/25$ V MLCC are used for the input capacitors. In addition, a bulk capacitor is recommended if the input supply is not located close to the voltage regulator.

17.4 Inductor Selection

The inductor is selected based on output power, operating frequency and efficiency requirements. A low inductor value results in a large ripple current, lower efficiency and high output noise, but helps with size reduction and transient load response. Generally, the desired peak-to-peak ripple current in the inductor (Δ i) is found between 20% and 50% of the output current.

The inductor saturation current must be higher than the maximum spec of the OCP limit plus the peak-to-peak inductor ripple current. For some core material, inductor saturation current may decrease with an increase in temperature. It is important to check the inductor saturation current at the maximum operating temperature.

The inductor value for the desired operating ripple current can be determined using the following relation:

$$L = (PV_{in(\max)} - V_o) \times \frac{D_{min}}{\Delta i_{L(\max)} \times F_{sw}}$$
$$D_{min} = \frac{V_o}{PV_{in(\max)}}$$
$$I_{sat} \ge OCP_{max} + \Delta i_{L(\max)}$$

Where: $PV_{in(max)} = Maximum$ input voltage; $\Delta iL_{max} = Maximum$ peak-to-peak inductor ripple current; $OCP_{max} = maximum$ spec of the OCP limit as defined in Section 15.1, and $I_{sat} = inductor$ saturation current. In this case, select inductor L =150 nH to achieve $\Delta iL_{max} = 25\%$ of I_{omax} . The I_{sat} should be no less than 56 A.

17.5 Output Capacitor Selection

The output capacitor selection is mainly determined by the output voltage ripple and transient requirements.

To satisfy the V_o ripple requirement, C_o should satisfy the following criterion.

$$C_o > \frac{\Delta i_{Lmax}}{8 \times \Delta V_{or} \times f_{sw}}$$

Where ΔV_{or} is the desired peak-to-peak output ripple voltage. For $\Delta i L_{max}$ = 7.5 A, ΔV_{or} =20 mV, f_{sw} = 800 kHz, C_o must be larger than 59 μ F. The ESR and ESL of the output capacitors, as well as the parasitic resistance or inductance due to PCB layout, can also contribute to the output voltage ripple. It is suggested to use Multi-Layer Ceramic Capacitor (MLCC) for their low ESR, ESL and small size.

To meet the transient response requirements, the output capacitors should also meet the following criterion.

$$C_o > \frac{L \times \Delta I_{o(\text{max})}^2}{2 \times \Delta V_{oL} \times V_o}$$

Where ΔV_{OL} is the allowable V_o deviation during the load transient. $\Delta I_{O(max)}$ is the maximum step load current. Please note that the impact of ESL, ESR, control loop response, transient load slew rate, and PWM latency is not considered in the calculation shown above. Extra capacitance is usually needed to meet the transient requirements. As a rule of thumb, we can triple the C_o that is calculated above as a starting point, and then optimize the design based on the bench measurement. In this case, to meet the transient load requirement (i.e. $\Delta V_{OL} = 30$ mV, $\Delta I_{O(max)} = 9$ A), select $C_o = \sim 600$ µF. For more accurate estimation of C_o , simulation tool should be used to aid the design.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Design example



17.6 Output Voltage Programming

Output voltage can be programmed with register bits and modified with PMBus or SVID commands, depending on chosen operating mode.

17.7 Bootstrap Capacitor

For most applications, a 0.1 μ F ceramic capacitor is recommended for the bootstrap capacitor placed between PHASE and BOOT. For applications requiring PV_{in} equal to or above 14 V, a small resistor of 1 - 2 Ω should be used in series with the BOOT pin to ensure the maximum SW node spike voltage does not exceed 20 V.

17.8 PVIN, and VCC/LDO bypass Capacitor

Please see the recommendation in 14.3 on the internal LDO. A 10 μ F MLCC is selected for the VCC/LDO bypass capacitor and a 4.7 μ F MLCC is selected for the PVIN bypass capacitor.

17.9 Design Recommendations

Listed below are the design recommendations for an application utilizing TDA38641.

- A 0 Ω resistor should be connected between Vcc and Vdrv
- A 100 Ω minimum load resistor should be connected across the output
- The GL pin should be floating. It is available for testing purpose only
- Pin 19 should be grounded
- AGND and PGND should be shorted with minimum possible impedance
- Add a 1 μF or a 2.2 μF 0402 ceramic cap across PVIN and PGND for high frequency decoupling
- Add a 1 μF or a 2.2 μF 0402 ceramic cap across PVIN and PGND for high frequency decoupling
- Check the sequence of PreBias, PVIN, VCC/VDRV and EN to meet the recommended sequence
- Check for proper selection of remote and local sense resistors.
- The LDO output should not be used to power external devices

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Layout Recommendations

18 Layout Recommendations

PCB layout is very important when designing high frequency switching converters. Layout will affect noise pickup and can cause a good design to perform with less than expected results. Following design guidelines are recommended to achieve the best performance.

- Bypass capacitors, including input/output capacitors Vcc/VDRV bypass capacitors, should be placed near the corresponding pins as close as possible.
- Place bypass capacitors from TDA38641 power input (Drain of Control MOSFET) to PGND (Source of Synchronous MOSFET) to reduce noise and ringing in the system. The output capacitors should be terminated to a ground plane that is away from the input PGND to mitigate the switching spikes on the Vo. The bypass capacitor shared by VCC and VDRV should be terminated to PGND.
- Place a boot strap capacitor near the TDA38641 BOOT and PHASE pin as close as possible to minimize the loop inductance.
- SW node copper should only be routed on the top layer to minimize the impact of switching noises
- On the TDA38641 demo board, AGND pin is connected to the exposed PGND pad with a copper trace using the shortest impedance path.
- Via holes can be placed on PVin and PGND pads to aid thermal dissipation.
- Wide copper polygons are desired for PVin and PGND connections in favor of power losses reduction and thermal dissipation. Sufficient via holes should be used to connect power traces between different layers.
- Output voltage sensing in TDA38641 is done differentially using the VOSENP and VOSENM pins.
 - A pair of PCB traces with at least 15 mil trace width, running close to each other and away from any noise sources such as inductor and SW nodes, should be used to implement Kelvin sensing of the voltage across a high-frequency bypass capacitor of 0.1 μF or higher.
 - o The ground connection of the remote sensing signal must be terminated at VOSENM pin.
 - The Vo connection of the remote sensing signal must be connected to the feedback resistor divider with the lower feedback resistor terminated at VOSENM pin for output voltages greater than 2.5 V.
 - o Shield the pair of remote sensing lines with ground planes above and below
 - o Do **NOT** connect VOSENM pin and AGND pin in this configuration
- For routing the SVID lines Intel's guidance on the spacing and length of the lines allowed (maximum) should be followed. One should also pay attention to the matching resistors and the pull-up requirements when routing these lines to multiple SVID slaves. All of this information is available in the Intel VR14 PWM spec document.
- The En pin and configuration pins including SV_ADDR/PROG should be terminated to a quiet ground. On the TDA38641 standard demo board, they are terminated to the PGND copper plane away from the power current flow. Alternatively, they can be terminated to a dedicated AGND PCB trace.

More information about the layout is found in the USER guide for the Eval Board for TDA38641. For more information on it please get in touch with the respective Sales team member

18.1 PCB Metal and Component Placement

Evaluation has shown that the best overall performance is achieved using the substrate/PCB layout as shown in the following figures. PQFN devices should be placed to an accuracy of 0.050 mm on both X and Y axes. Self-centering behavior is highly dependent on solders and processes, and experiments should be run to confirm the limits of self-centering on specific processes. For further information, please refer to the "Recommendationd for Board Assembly of Infineon Integrated Packages without Lead" Application note https://ecmpub.infineon.com/dctm-publish/ecmdata/tech_0460/Z8F80291788.pdf.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Layout Recommendations

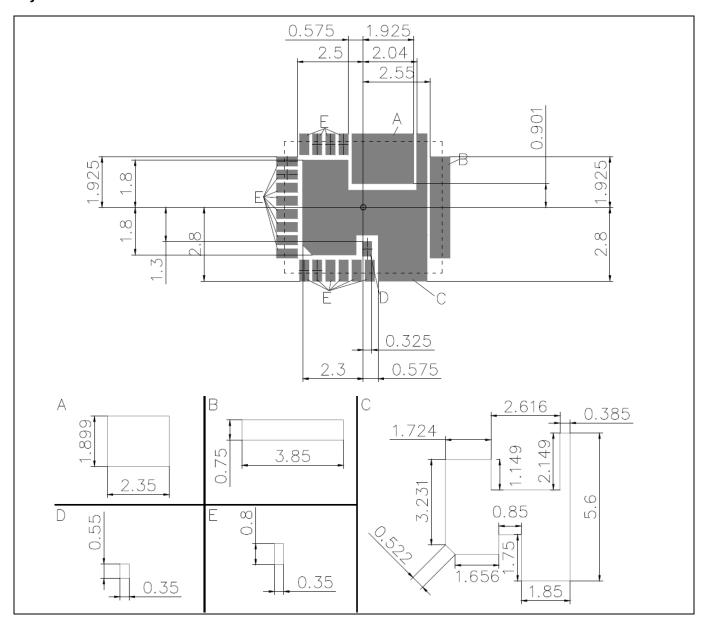


Figure 21 PCB metal pad sizing and spacing (all dimensions in mm)

18.2 Solder Resist

Infineon recommends that larger Power or Land Area pads are Solder Mask Defined (SMD.) This allows the underlying copper traces to be as large as possible, which helps in terms of current carrying capability and device cooling capability. When using SMD pads, the underlying copper traces should be at least 0.05 mm larger (on each edge) than the Solder Mask window, in order to accommodate any layer to layer misalignment. (i.e. 0.1 mm in X & Y.) When using NSMD pads, the Solder Resist Window should be larger than the Copper Pad by at least 0.025 mm on each edge, (i.e. 0.05 mm in X&Y,) in order to accommodate any layer to layer misalignment. Ensure that the solder resist in-between the smaller signal lead areas is at least 0.15 mm wide, due to the high x/y aspect ratio of the solder mask strip.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Layout Recommendations

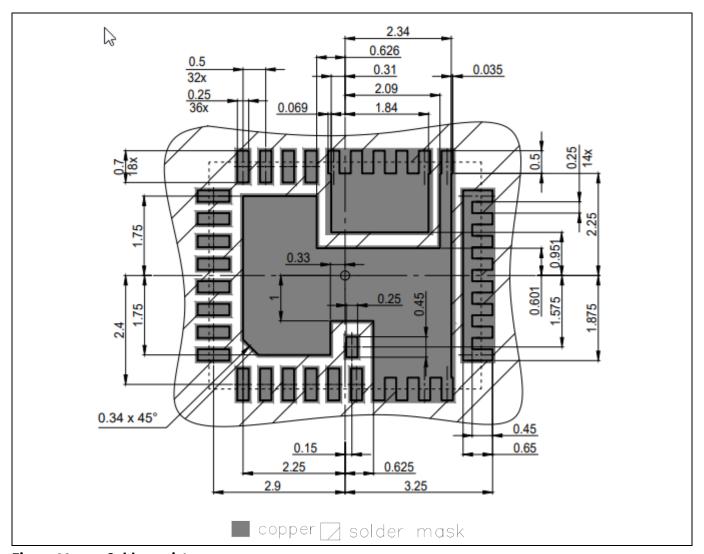


Figure 22 Solder resist

18.3 Stencil Design

Stencils for PQFN packages can be used with thicknesses of 0.100-0.250 mm (0.004-0.010"). Stencils thinner than 0.100 mm are unsuitable because they deposit insufficient solder paste to make good solder joints with the ground pad; high reductions sometimes create similar problems. Stencils in the range of 0.125 mm-0.200 mm (0.005-0.008"), with suitable reductions, give the best results.

A recommended stencil design is shown in Figure 23. This design is for a stencil thickness of 0.127 mm (0.005"). The reduction should be adjusted for stencils of other thicknesses.

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Layout Recommendations

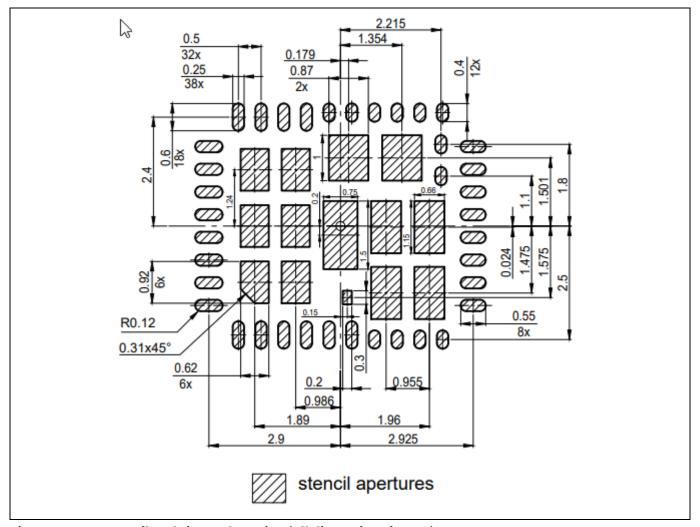


Figure 23 Stencil pad size and spacing (all dimensions in mm)



19 Package

Package

19.1 Marking Information

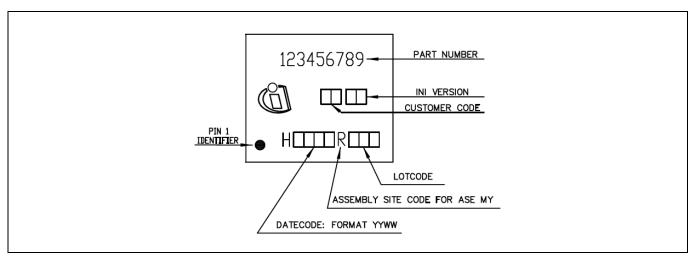


Figure 24 Package Marking

19.2 Dimensions

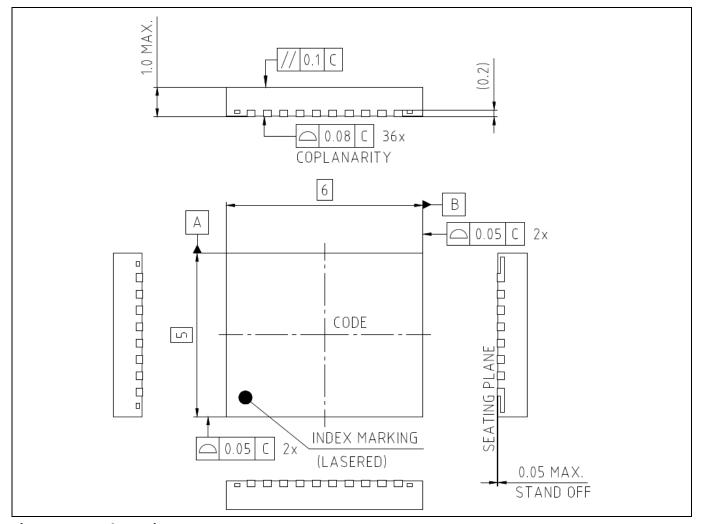


Figure 25 Package view

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Package

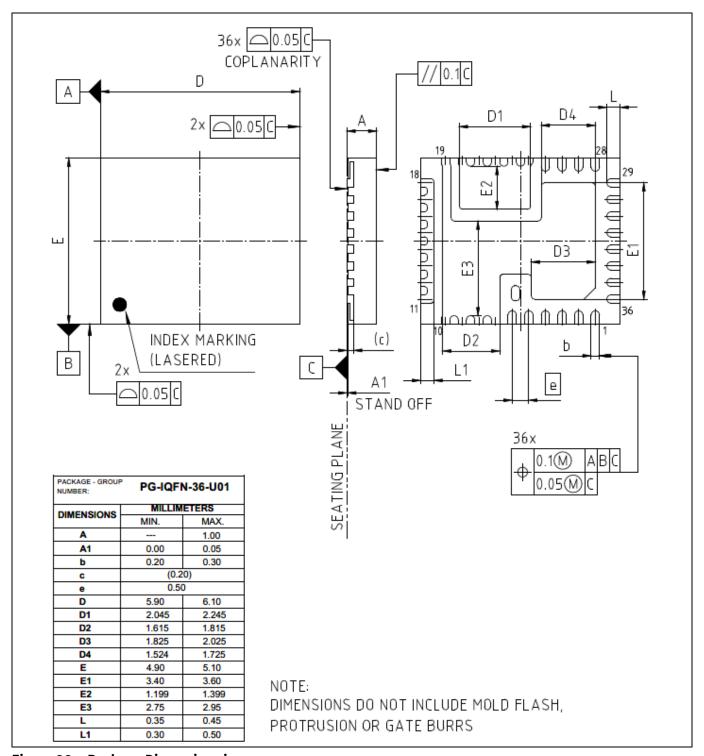


Figure 26 Package Dimensions in mm

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID



Package

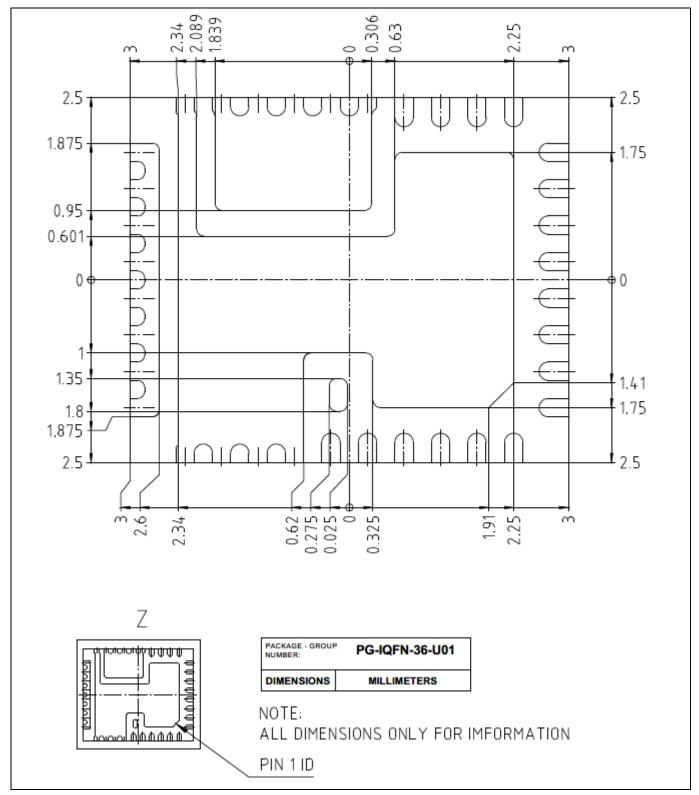


Figure 27 Package Dimensions- Pad Layout

Package



19.3 Tape and Reel Information

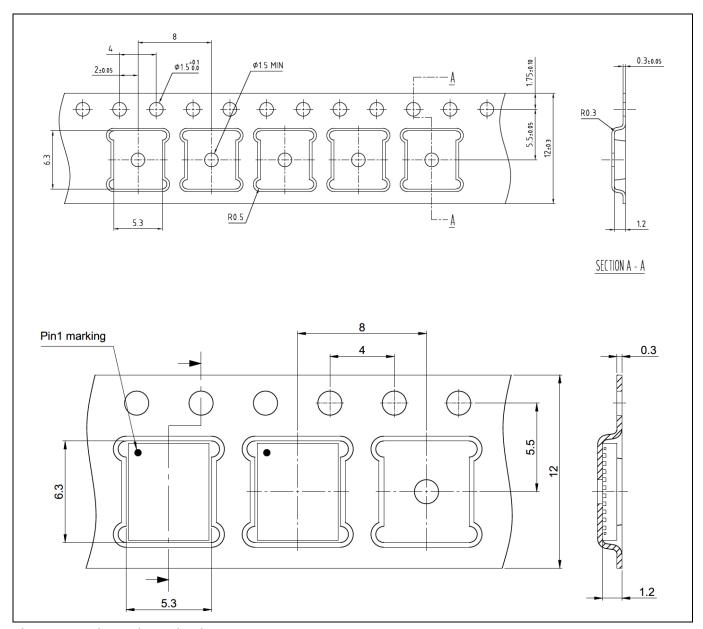


Figure 28 Pin 1 orientation in the Tape & reel

40A Single-voltage Synchronous Pin Programmable Buck Regulator with SVID Environmental Qualifications



20 Environmental Qualifications

Table 21 Enviormental Qualification Specs

Qualification Level		Ind	Industrial		
Moisture Sensitivity		5 x 6 mm QFN Package	JEDEC Level 2 @ 260°C		
	Human Body Model	ANSI/ESDA/JEDEC JS-001, Cla	ANSI/ESDA/JEDEC JS-001, Class 2 (2000 V to < 4000 V)		
ESD	Charged Device Model	ANSI/ESDA/JEDEC JS-002, Cla	ANSI/ESDA/JEDEC JS-002, Class C3 (≥ 1000 V)		
RoHS2 Compliant		Annex II to EU Directive 201	This product follows EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU(RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders		

TDA38641



Revision History

TDA38641

Revision 2024-05-23, Rev. 2.3

Previous	Revision	
Revision	Date	Subjects (major changes since last revision)
2.0	2022-11-11	Release of final version
2.1	2022-11-21	Updated the section on Programming, pre-bias startup section and package drawing. Updated the TON/MODE pin current in EC table and corrected the abs max table.
2.2	2023-11-01	Updated the package drawings in figure 25, 26, and 27. Updated the tape and reel information in figure 28. Updated App note reference in section 18.1 Updates LDO test current to 50mA updated the OPN
2.3	2024-05-23	Datasheet revision 2.3 changes are specific to IC_Device_ID -A7h for TDA38641. Please refer to prior Datasheet revision 2.8 for IC_Device_ID -83h for TDA38641. Changed the LDO test current to 50mA in EC table Updated Electrical Characteristics table - Improved UVP and OVP accuracy Update available number of single image/multiimage config to 13 with no restrictions in MTP section 13.6 Updated the prebias section 14.2 with improved prebias level operation and supported power sequence to enable pre-bias startup Added voltage sense section 13.2 to show calculation for voltage sense for the Vout scale loop 1:2 to obtain output voltages in the range of 2.56V to 3.04V. Updated TOFF_FALL and Mfr_id register descriptions in section 16.2 Updated ILIM resistor table in Section 8 Updated AOCP operation diagram in section 15.1 Updated Device_ID register

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descriptions in section 16.2. Added Note 17.

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TDA38641



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